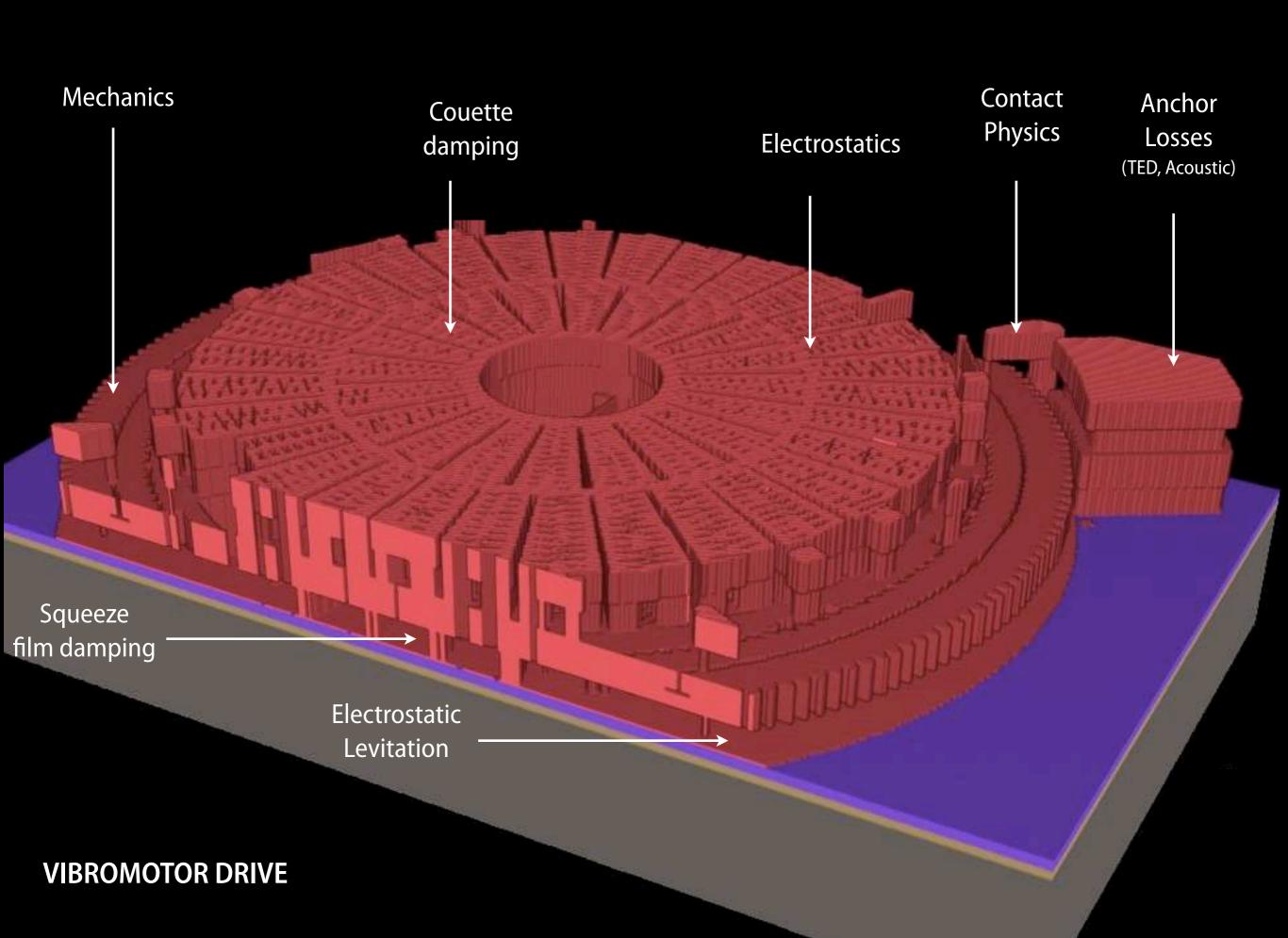


Design Flow in IntelliSuite v8.6

# Design flow





# Colliding domains

**Mechanics** 

**Electrostatics** 

**Magnetostatics** 

**Fluidics** 

**Optics** 

Electromagnetics

**Acoustics** 

**Biochemistry** 

**Electrokinetics** 

**Piezoelectrics** 

**Ferromagnetics** 

**Piezoresistive** 

Magnetorestrictive

**Proteomics** 

Genomics

**MATERIALS** 

**Electronics** 

Biology

Control theory

### **Systems**

Process design

Process simulation

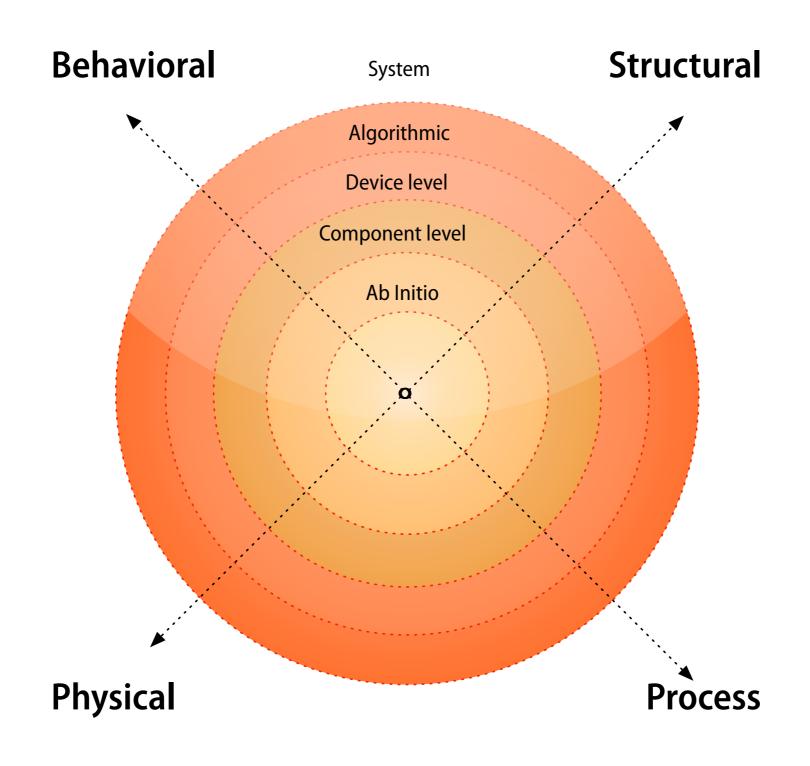
**Packaging** 

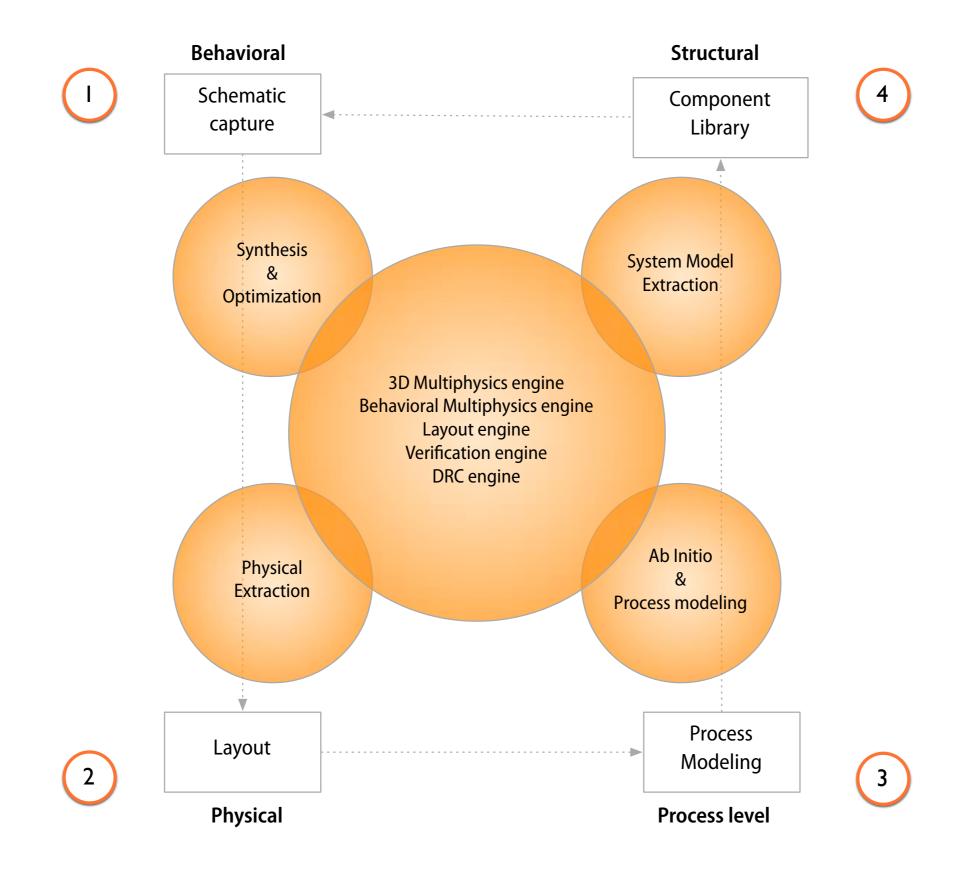
Yield optimization

DfM

PHYSICS MANUFACTURING

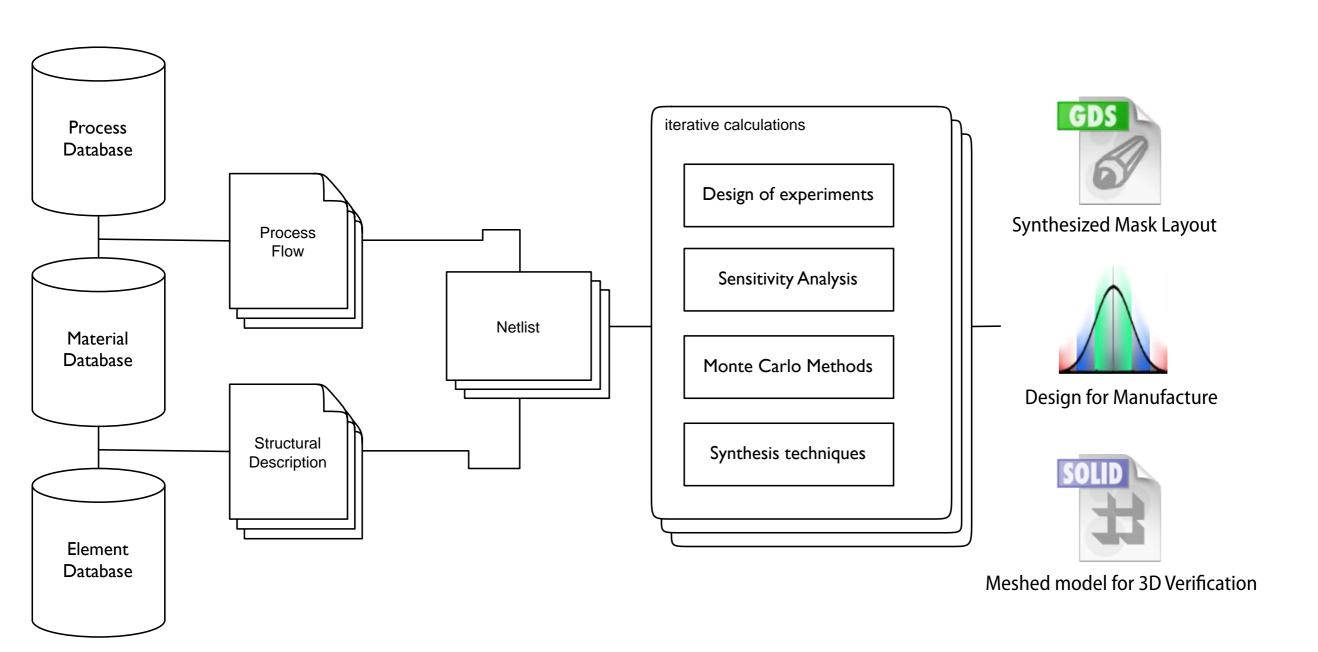
### Hierarchy of MEMS modeling





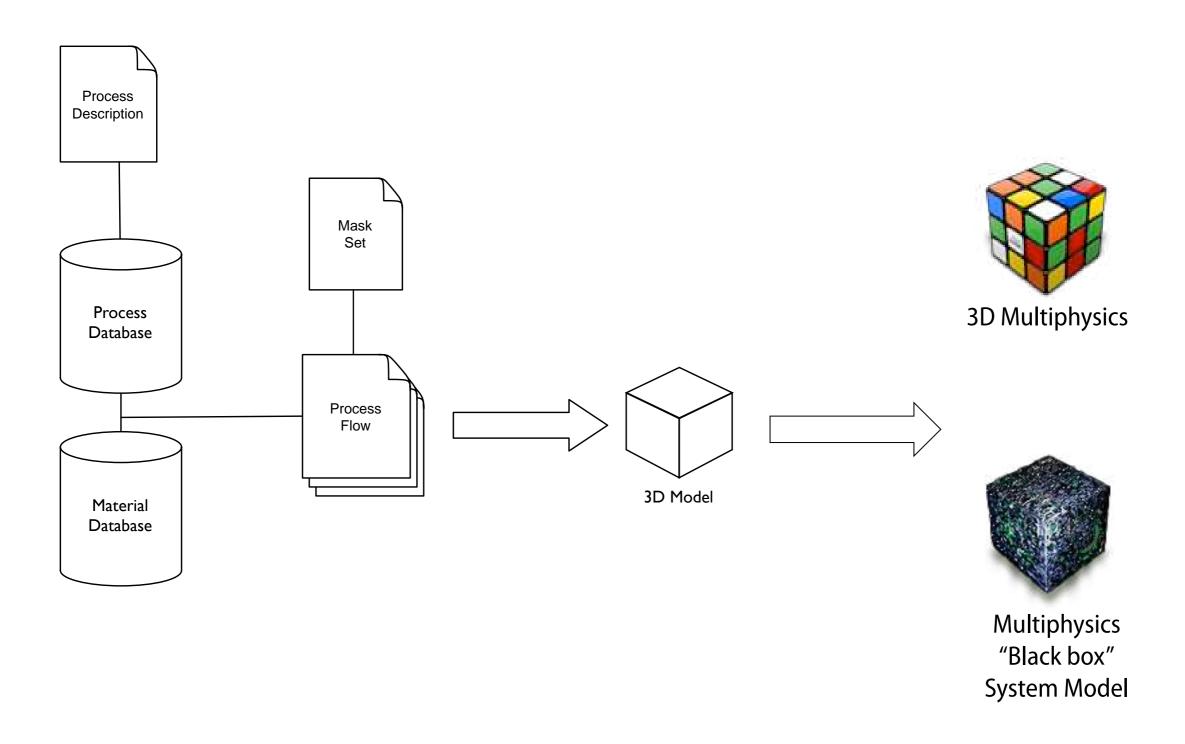
### Seamless integration of design flow...

### Top down flow: schematic based...



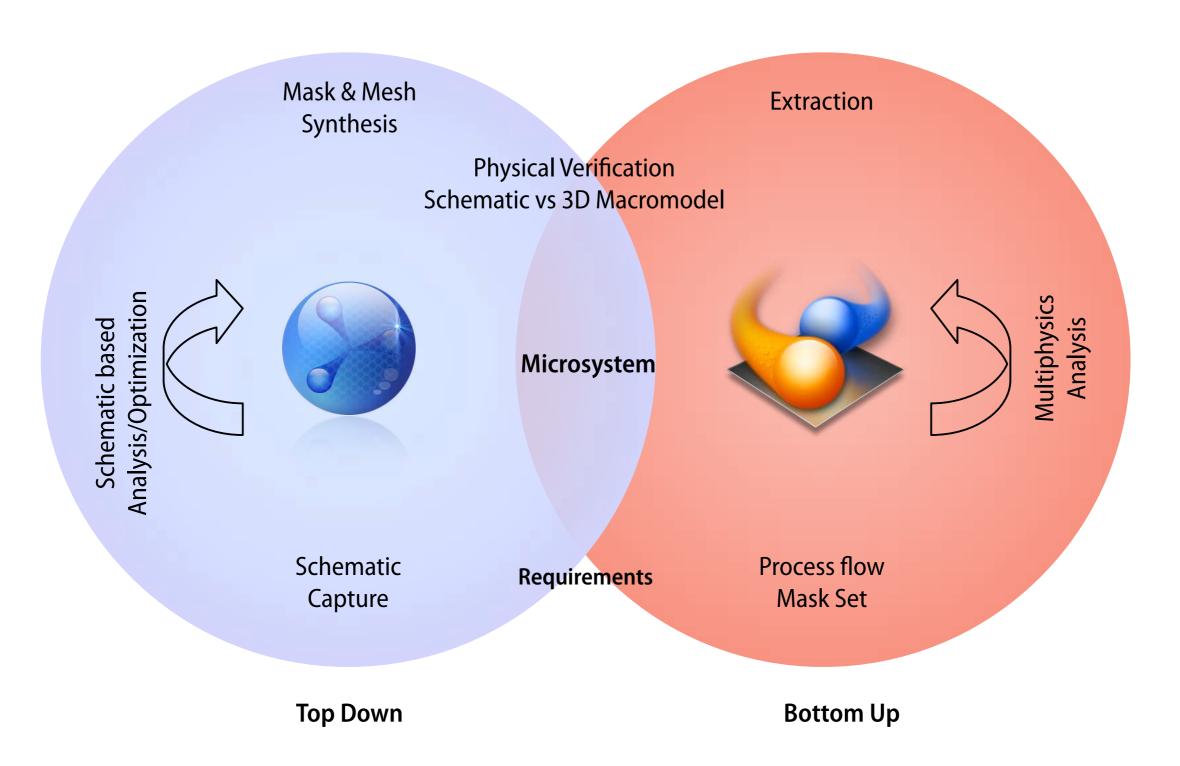
Fast but less accurate...

### Bottom up design flow: 3D based



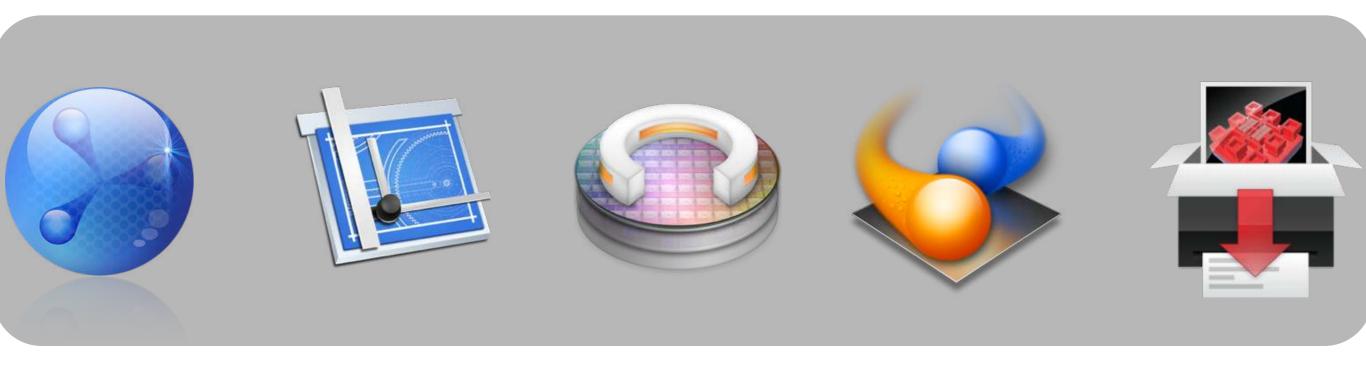
Accurate but slower...

### IntelliSuite: Best of both worlds



Accurate + Fast

### IntelliSuite Tool Chain



#### **Synple**

Schematic capture
Component based
Design exploration
Mask and 3D synthesis

#### Blueprint

Physical design Layout/DRC Tape Out

#### **Clean Room**

Process flow design Process debug Process visualization

#### **Fast Field**

Multiphysics solvers Coupled field analysis System model extraction

#### **EDA Linker**

Link to EDA tools Cadence, Mentor, Synopsys, Ansoft, Mathworks etc...

# Behavioral modeling



### Synple capabilities (Behavioral)











#### **Schematic capture**

Design Exploration
Optimization
Design for manufacture

#### **Multiphysics computation**

Mechanics
Electrostatics
Damping/Dissipation
Piezo
Mixed Signal
Control Systems
1000X faster than FEA

#### **Synthesis**

Schematic to mask Schematic to 3D Schematic to mesh

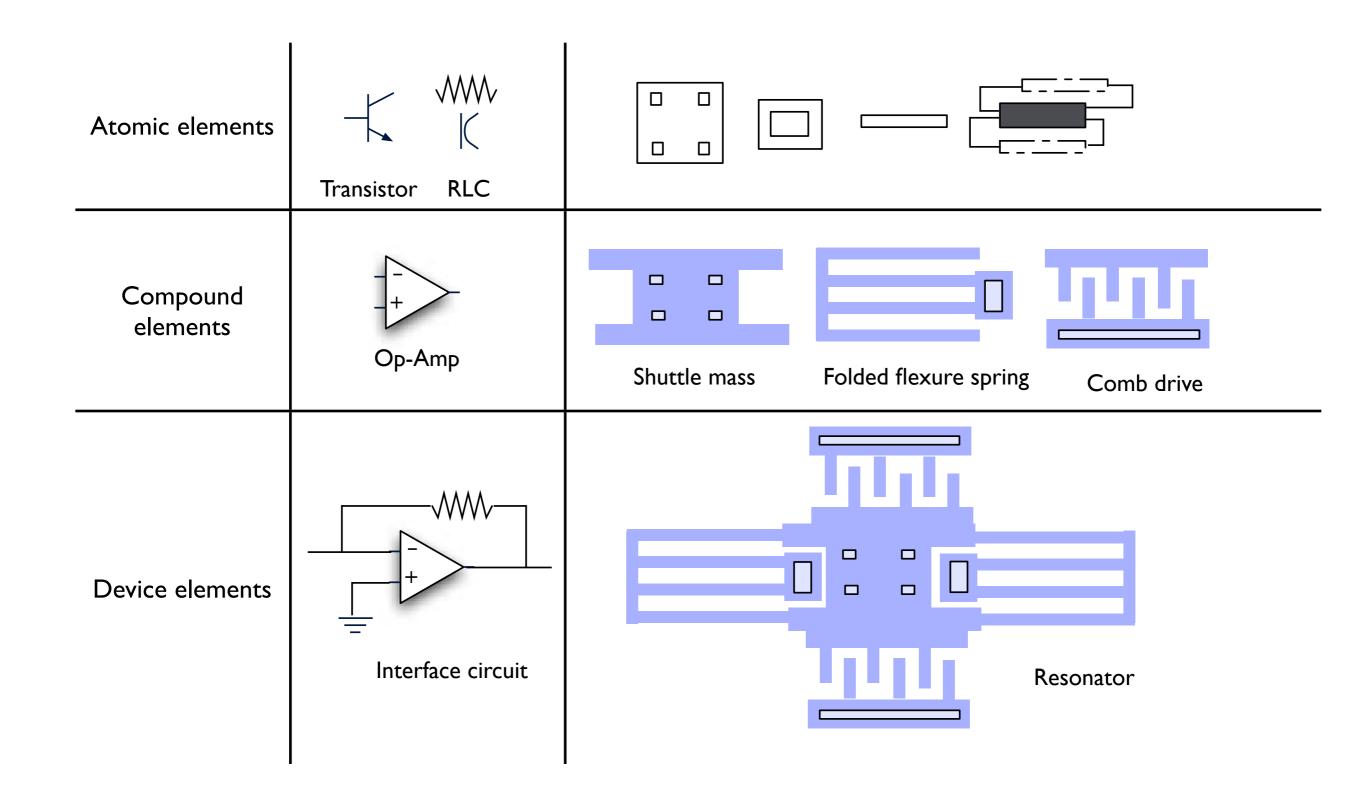
#### **Yield Engineering**

DfM Process Corner studies Yield prediction

Link to other tools

Automatic meshing Derive process flow

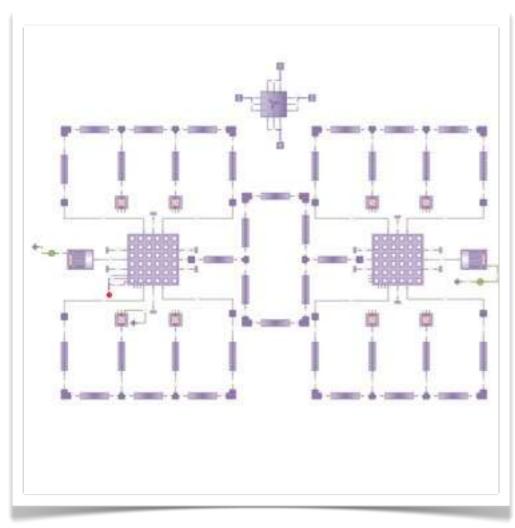
### Hierarchical multi-domain design



0					
	ELECTRICAL	DIGITAL	ELECTRONICS	CONTROLS	
	STRUCTURAL MECHANICS	THERMAL	MEMS	MACRO- MODEL	
	MECHANICS	THERMAL	MEMP	MODEL	

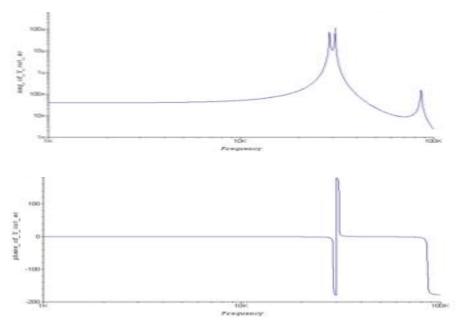
### WIDE RANGE OF BUILDING BLOCKS

### Schematic based design exploration

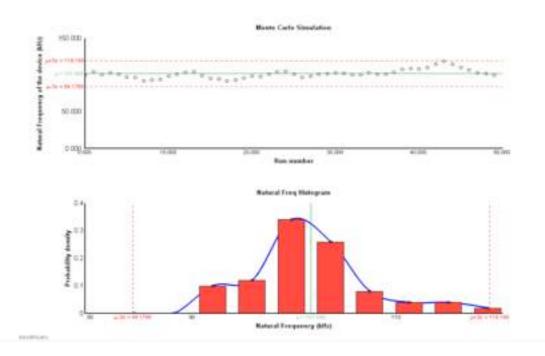


Band pass filter



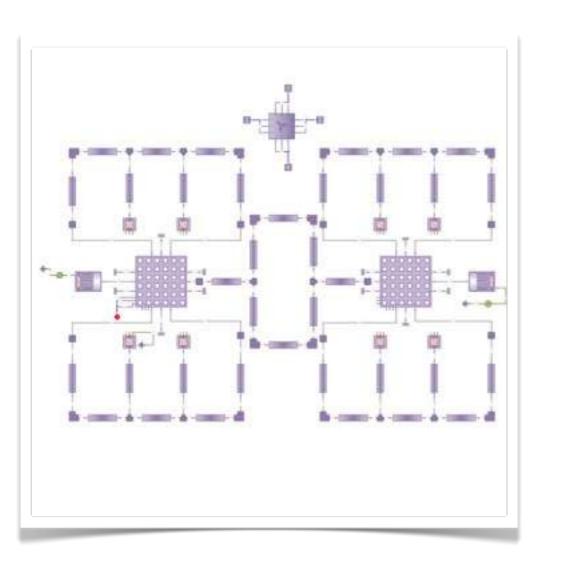


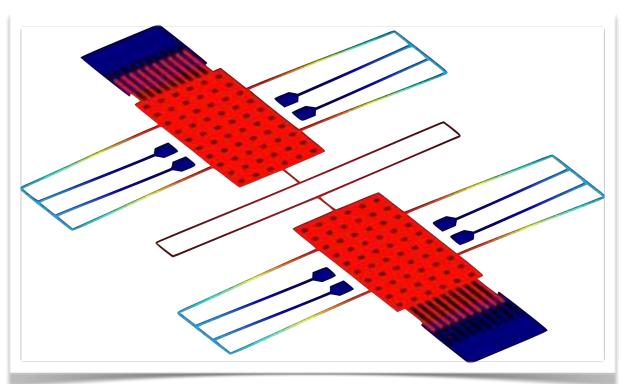
Compute time: 4 hr (Full 3D) vs 30s (compact)



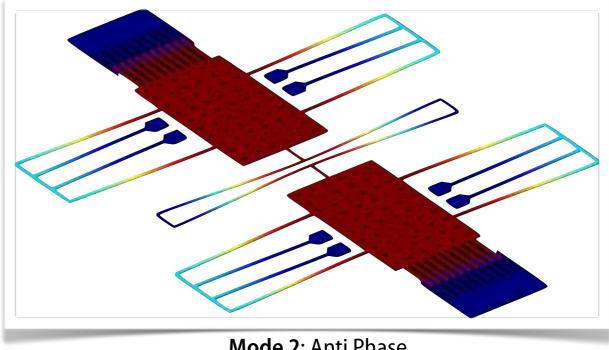
Monte Carlo based process variation analysis

### Visualize schematic results in 3D



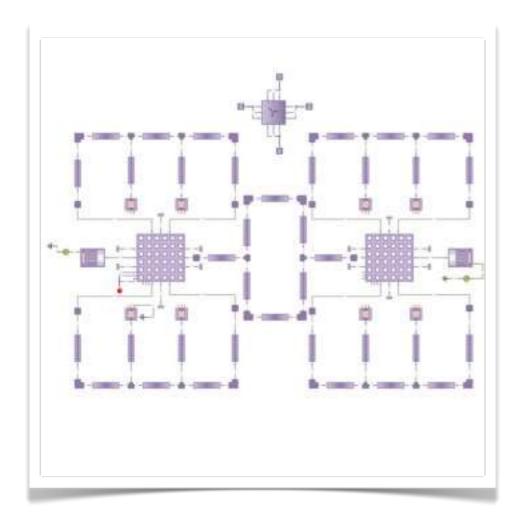


Mode 1: In Phase

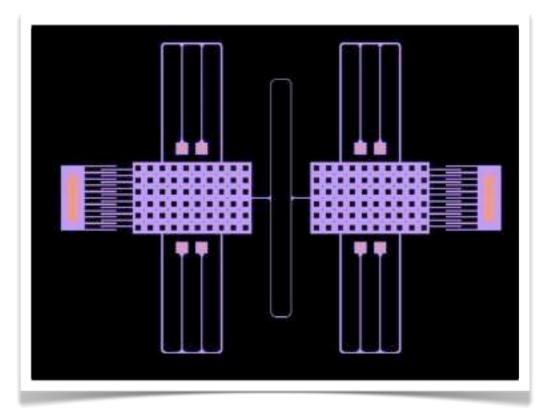


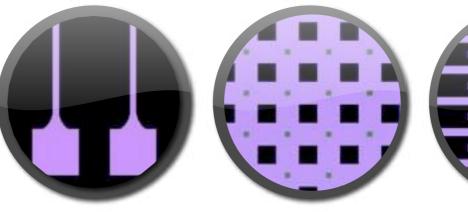
Mode 2: Anti Phase

### Schematic to mask



#### **Automated layout synthesis**





Stress relief curves

Dimples

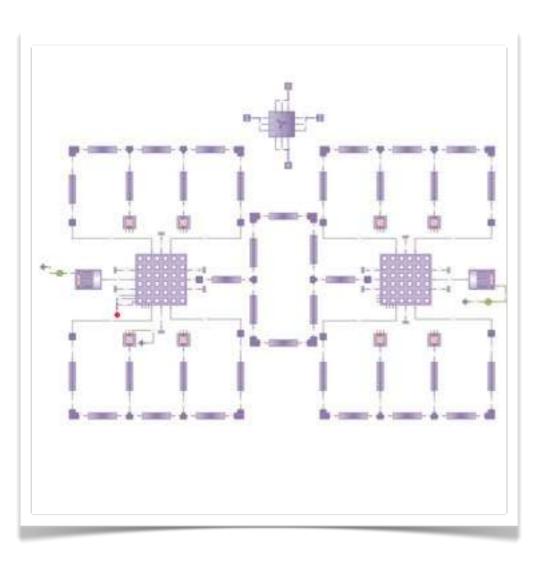
Comb bumpers



Etch compensation features

Attention to detail

### Schematic to process flow

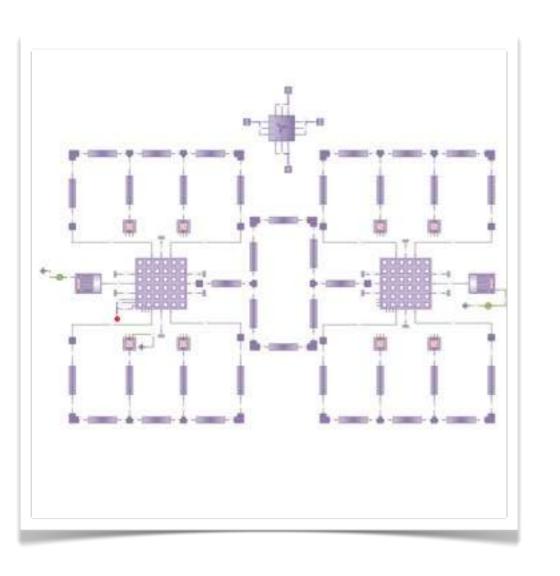


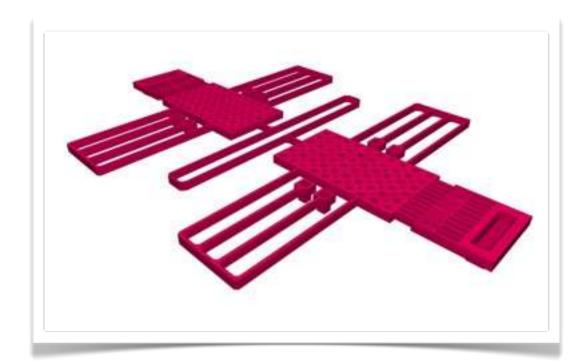


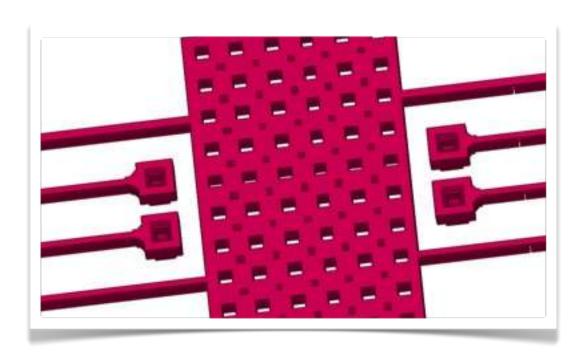


Process flow for fabricating the device is automatically derived from the schematic and technology file information

### Schematic to 3D model



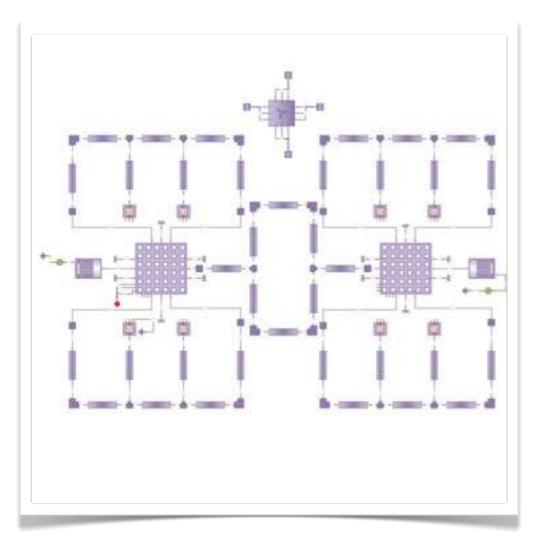


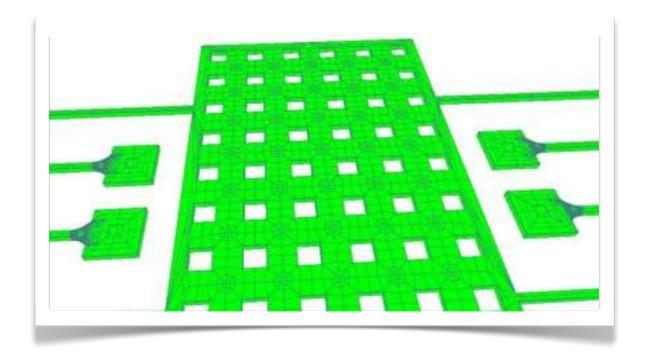


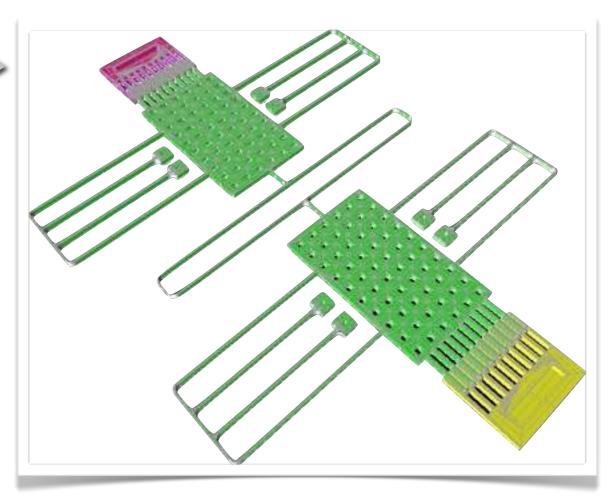
#### Attention to detail

Automatic placement of dimples, anchors and other secondary features

### Schematic to mesh







Automated Hexahedral Meshing of the Structure

## Benefits

Schematic driven design

Entry point for parametric design and design exploration

Hierarchical modeling

Model your device at system or circuit level

Save time

100-1000X faster than FEA models.

Design exploration and optimization

Quickly prototype and explore multiple designs

3D System modeling

View your results in 3D



# Physical design & verification



### Blueprint capabilities (Physical)









#### **Design capture**

Layout optimized for MEMS
AutoCAD™ like interface
Large design library
Hierarchy support
Smart Layers
Pathfinders
Scripting

#### **Design Rule Check**

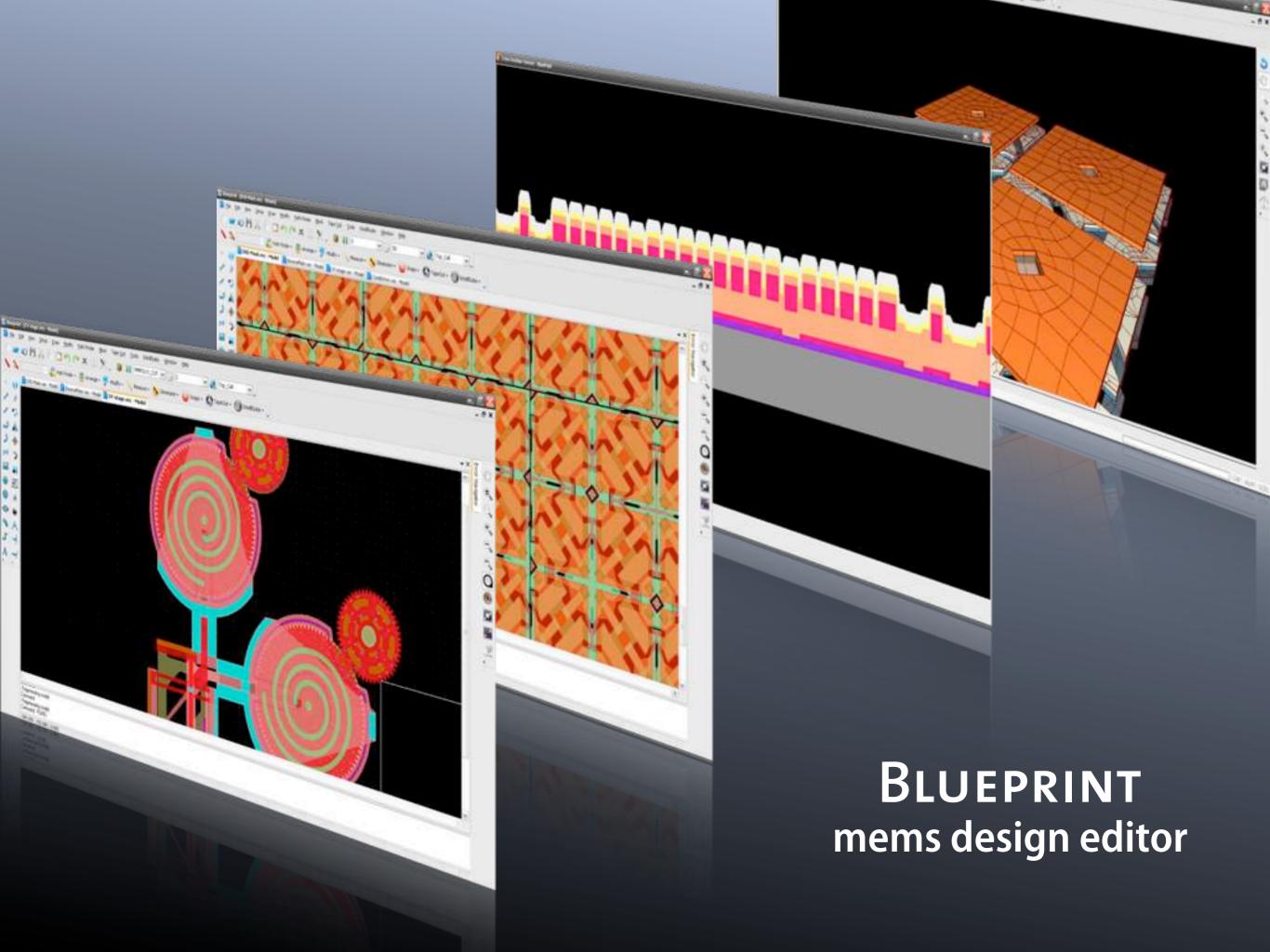
Tape Out DRC Editor
Powerful hierarchical DRC
All angle support
Easy Error Navigator

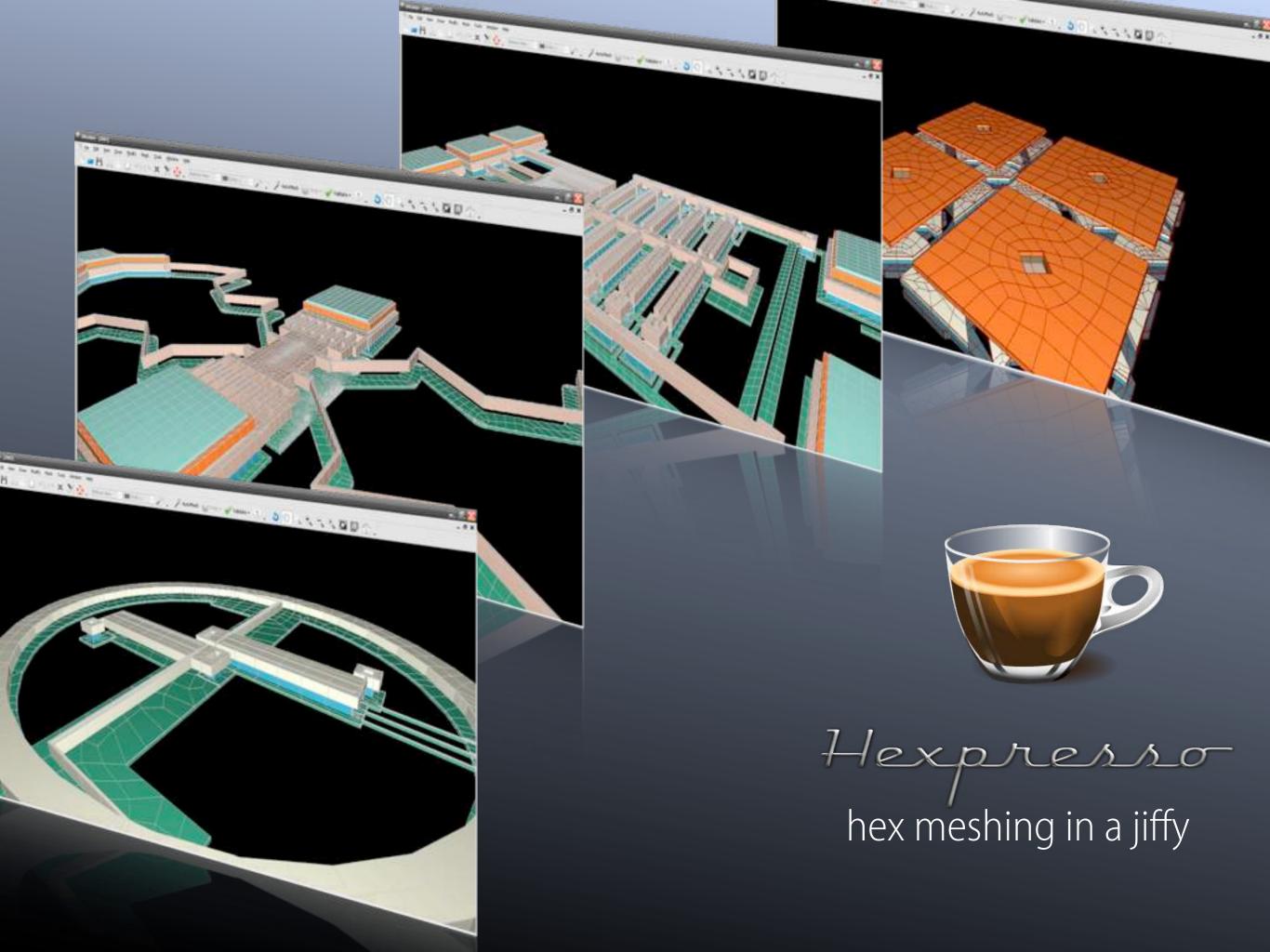
### Layout visualization

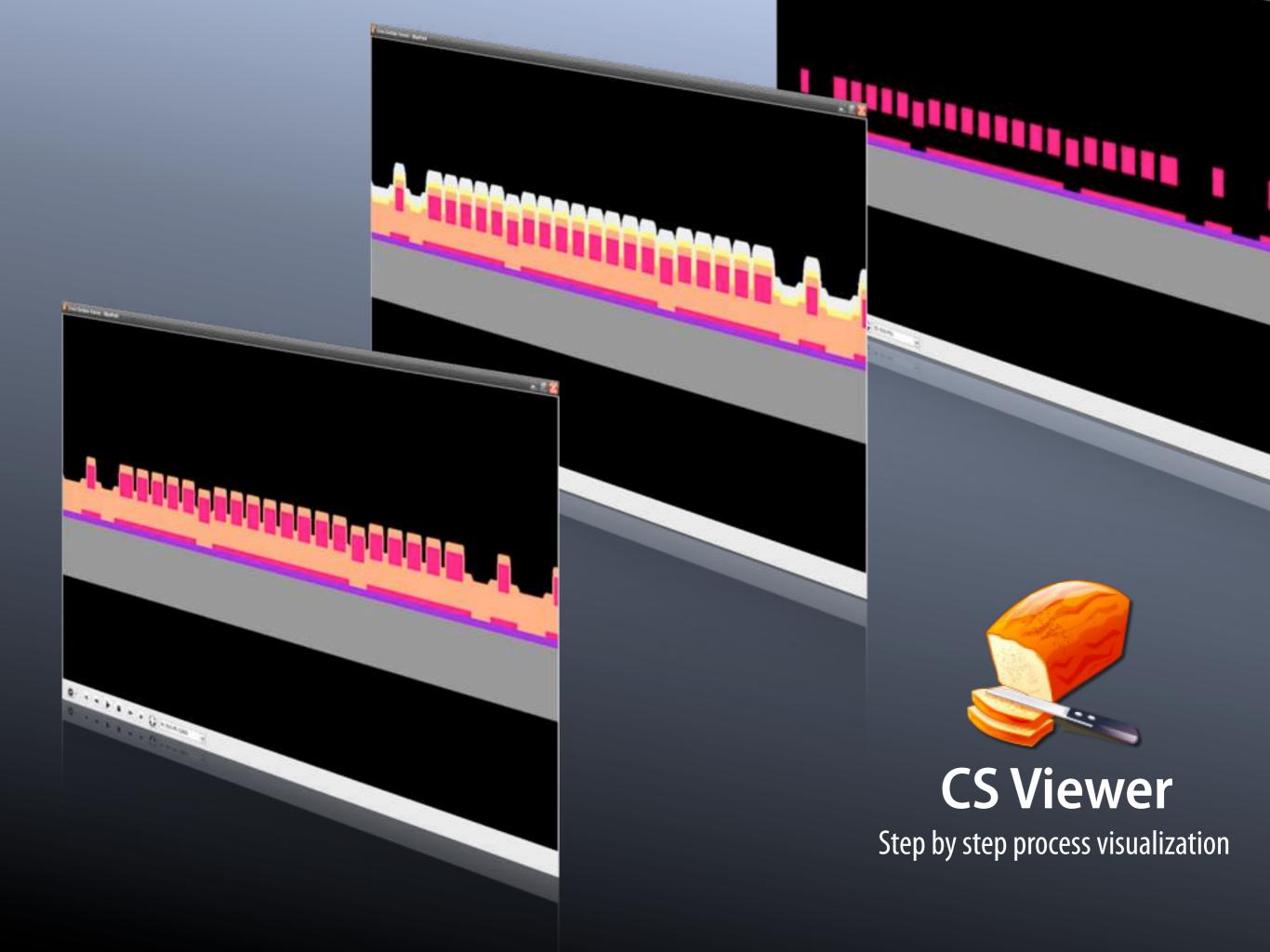
Cross section drawing
3D Visualization of layout

#### Hexpresso

Automated HEX mesher
1 click Mask to Mesh

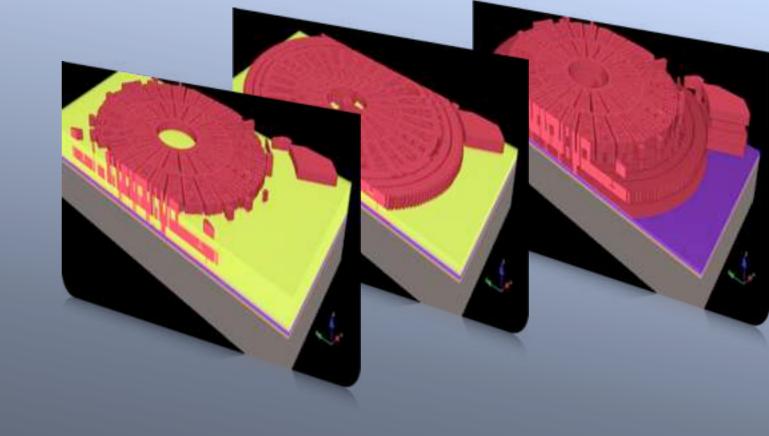


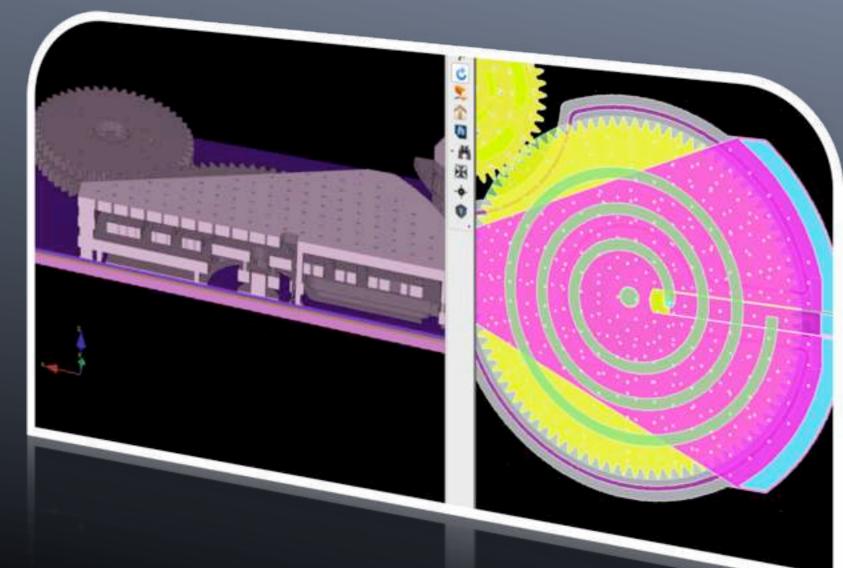


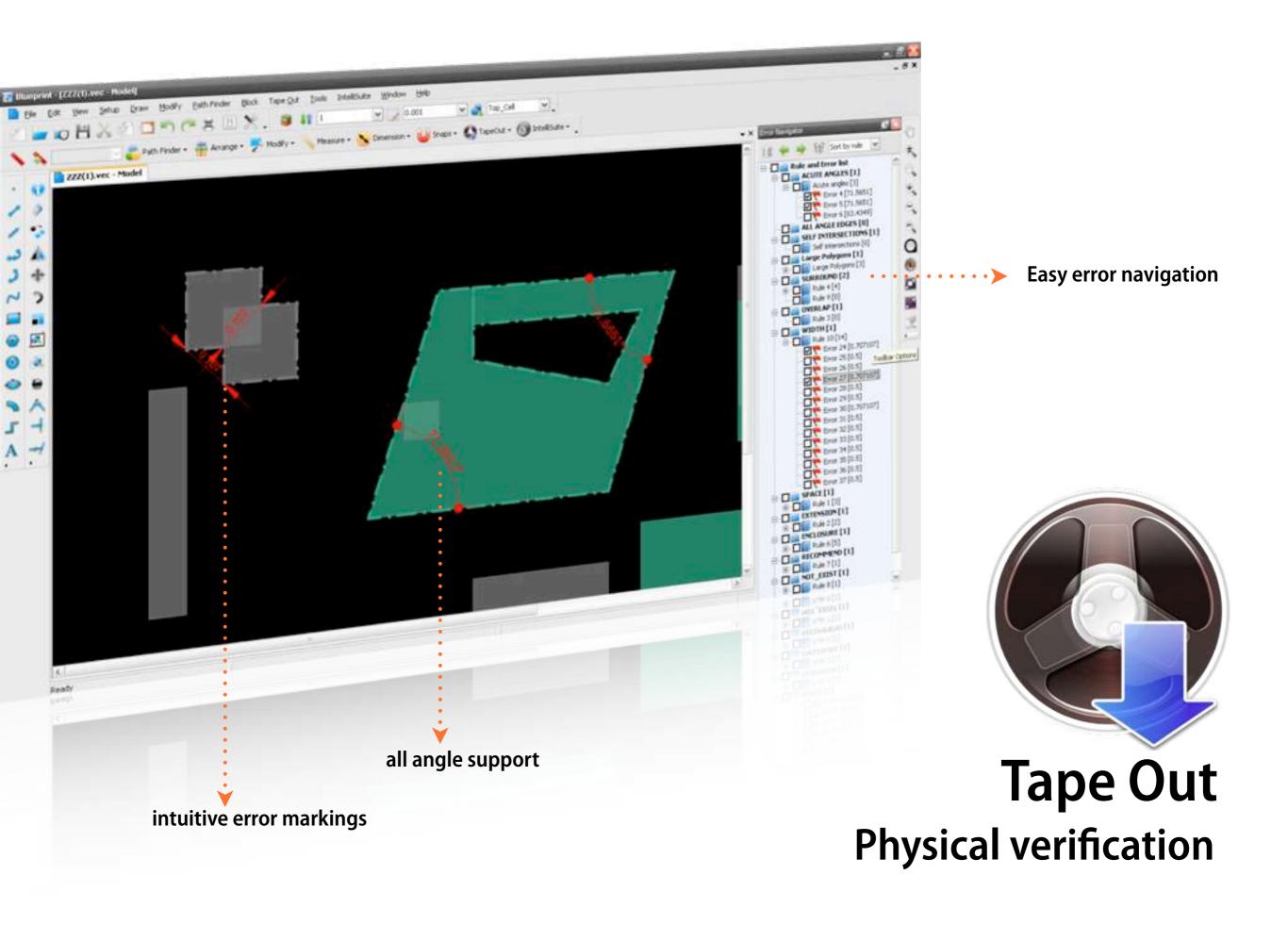




# Cleanroom integration









- Tightly integrated with layout
- Step by step process visualization
- Process debug
- Output cross sections to Powerpoint



hex meshing in a jiffy

- One click meshing
- Mask to mesh
- Process based meshing
- Adaptive meshing
- Quick and robust mesher

# Process validation



## What is Clean Room?

# Process simulation and visualization

State of the art 3D process modeling

### **RECIPE**

RIE/ICP/Bosch etch simulation STS etch database

### IntelliEtch

Ab initio based etch modeling wet and dry etch modeling

### **MEMaterial**

Material databases & process optimization

### **IntelliFAB**

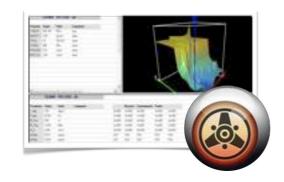
Process traveller creation and visualization.

### Hexpresso

Automated hexahedral meshing engine for FEA/BEA model creation

### Clean Room capabilities (Process)









#### **Process capture**

Develop process traveller Debug traveller Create process databases

#### **Material databases**

Process correlated databases Material properties

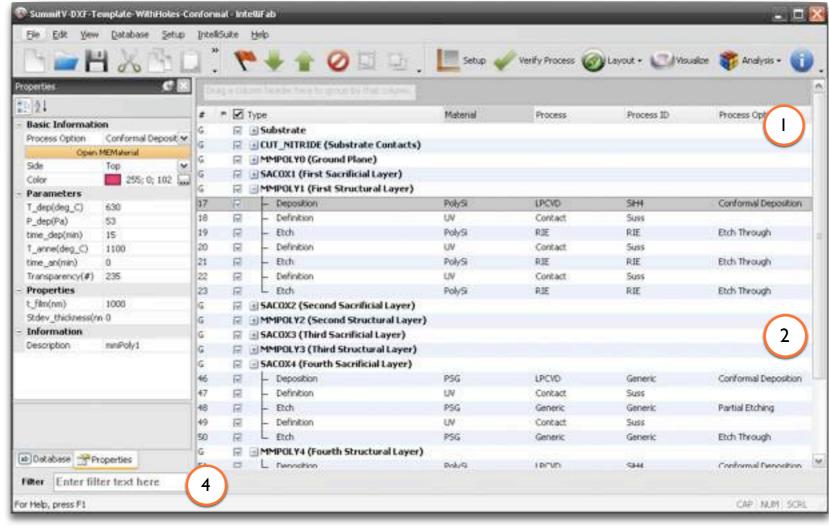
#### **Process simulation**

**FABViewer**: Flow visualization **AnisE** - Anisotropic etching **IntelliEtch** - *ab initio* etching **RECIPE** - RIE/ICP etch simulator

#### Hexpresso

Automated HEX mesher
1 click Mask to Mesh

### Setup complex process flows...



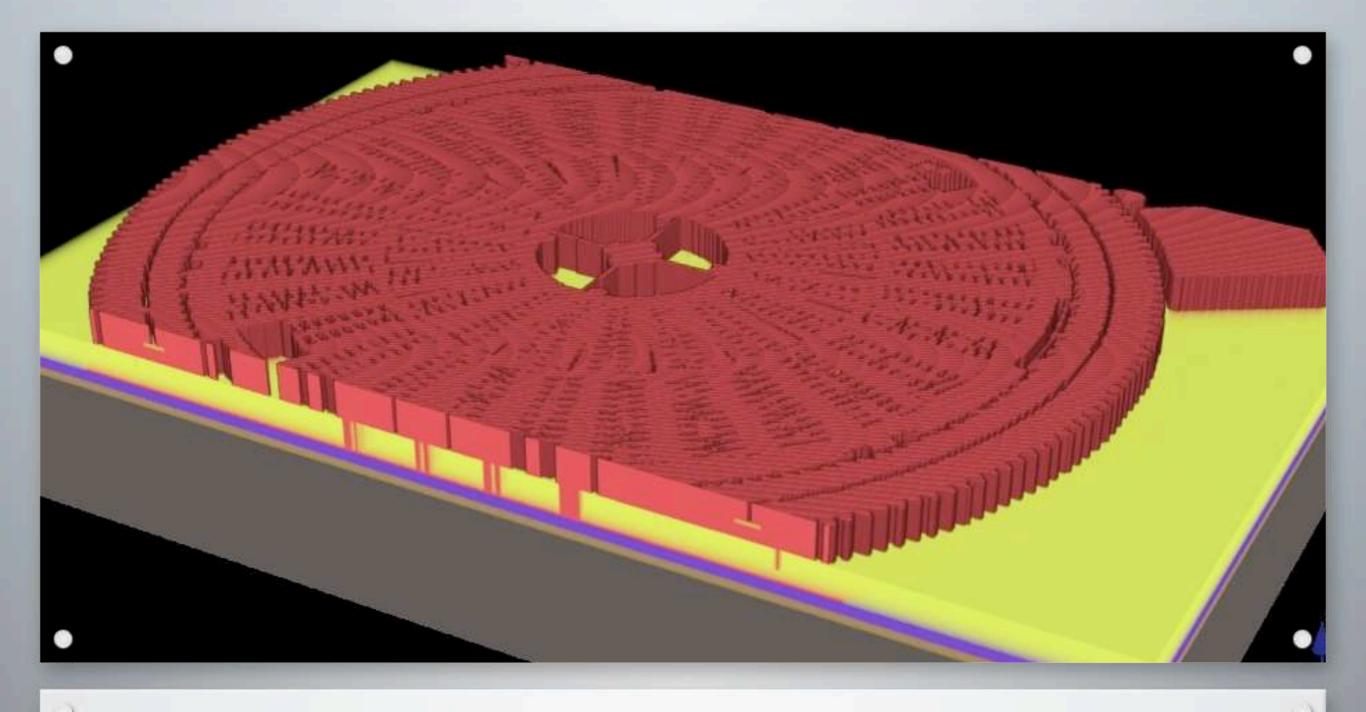
**Process Pane** 

Enter process parameters, tolerances and visualization settings in a single consolidated pane

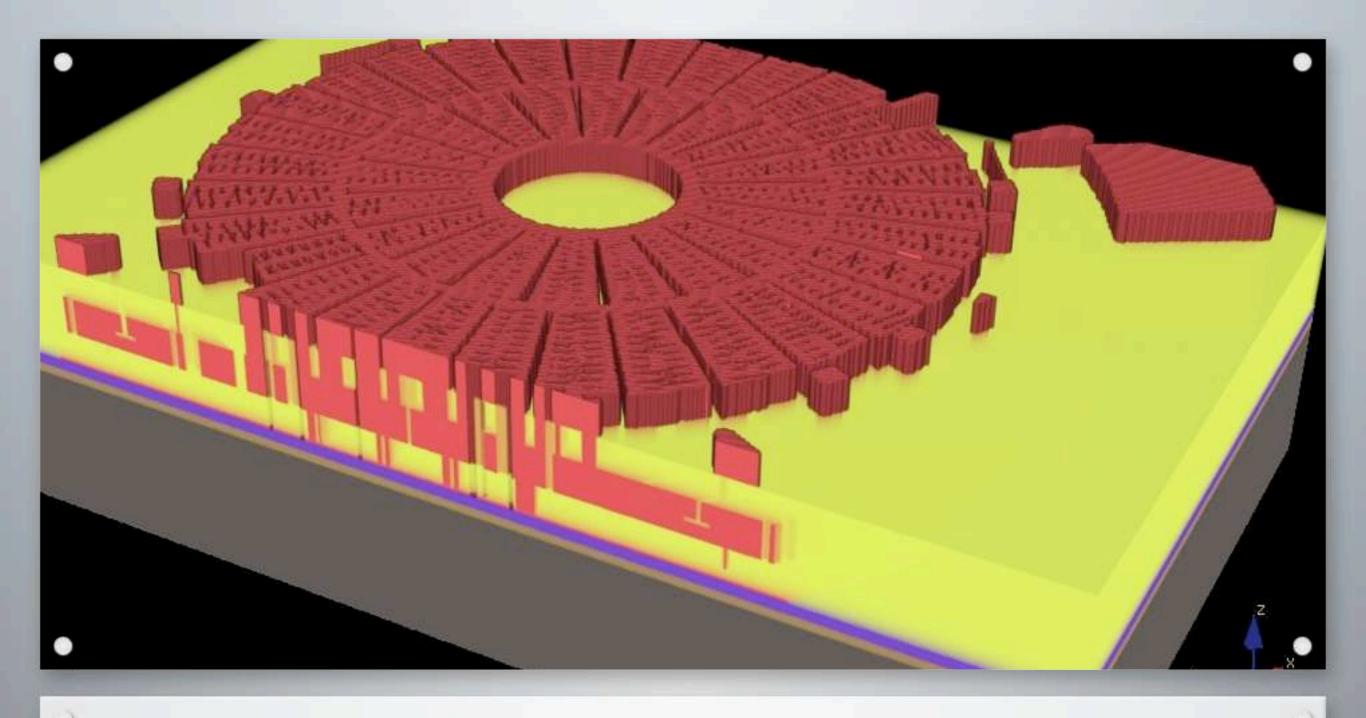
Filter with ease

Filtering tools allow you to quickly focus on the processes that you want to explore Process Editor for MEMS
IntelliFAB makes editing
and organizing a process
table quick and easy. Setup
your virtual process traveller
exactly as you would for a
real foundry.

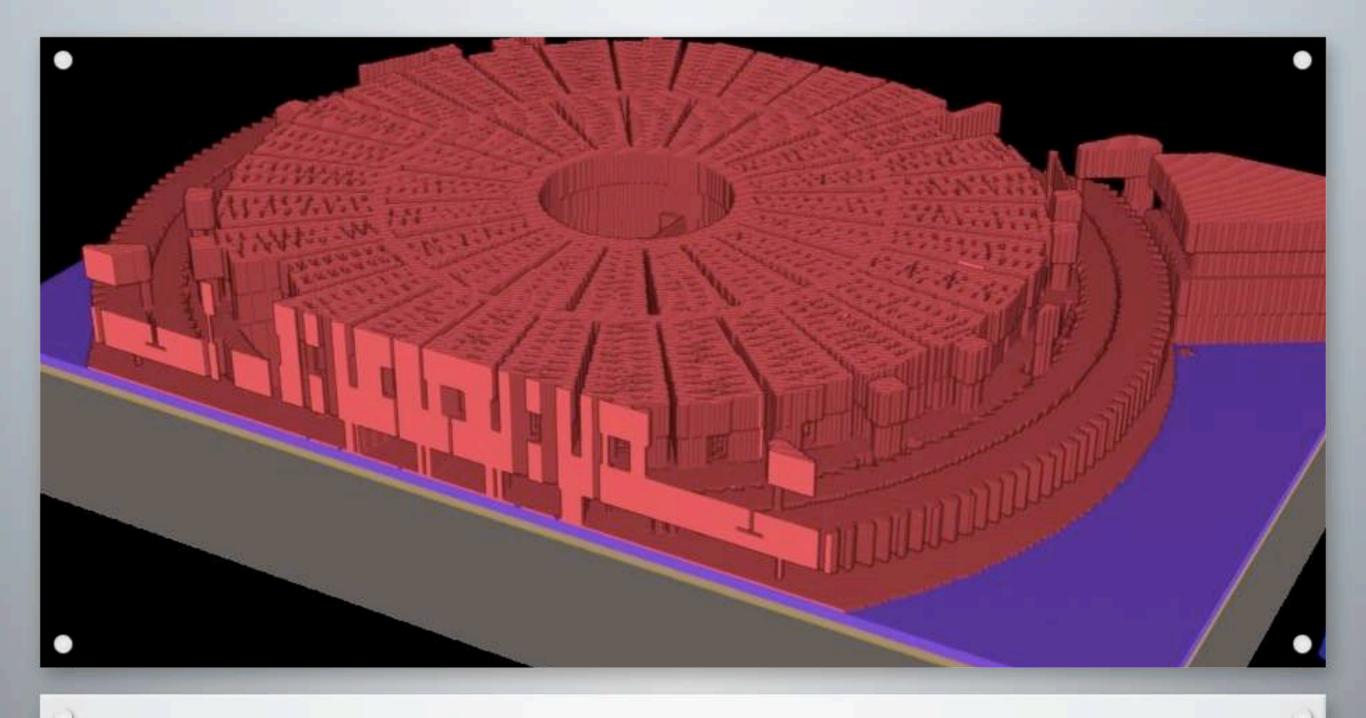
Group, section, organize
Grouping common sets of
processes into process
subsets makes the
organizing a complex
traveler easy. You can group
your process flow in any
which way you please: by
material, by process type or
by process option.



# VISUALIZE COMPLEX PROCESS FLOWS

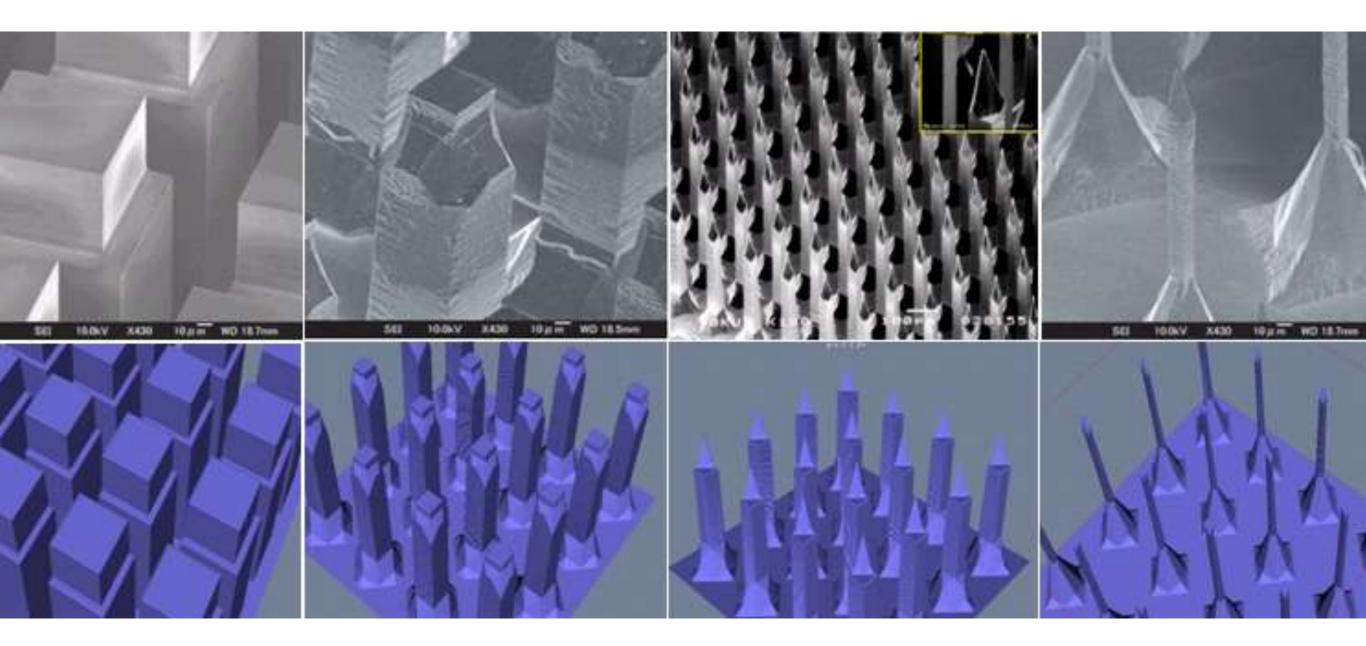


# VISUALIZE COMPLEX PROCESS FLOWS



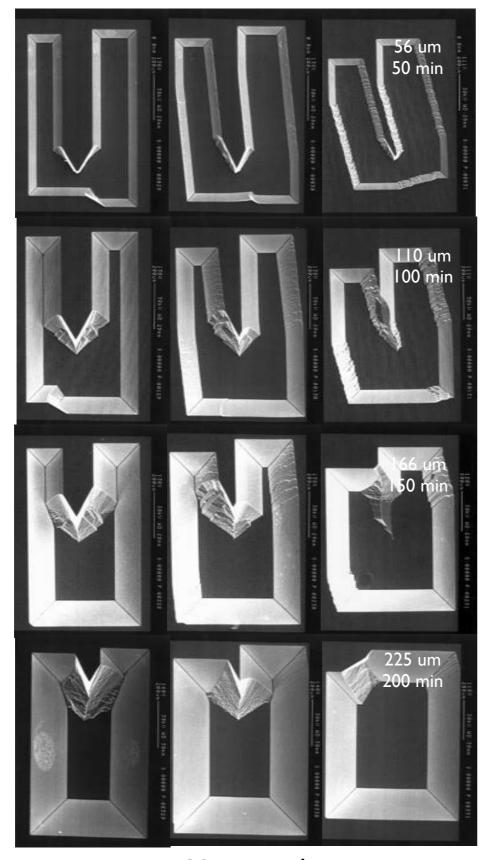
# VISUALIZE COMPLEX PROCESS FLOWS

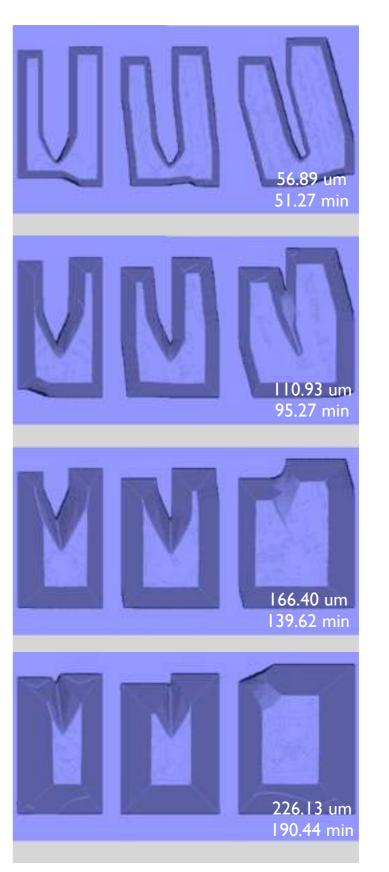
## Simulate composite MEMS processes



Combination of multi-step mask transfers, oxide and nitride layers, sacrificial layer deposition and wet etching and DRIE processes.

### Validate processes in design

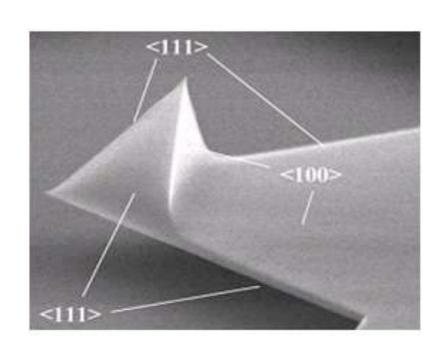




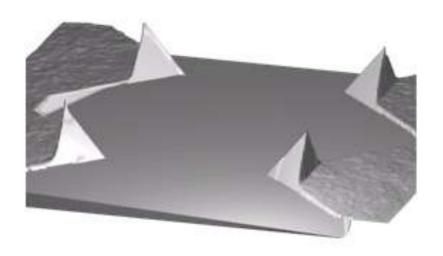
Measured

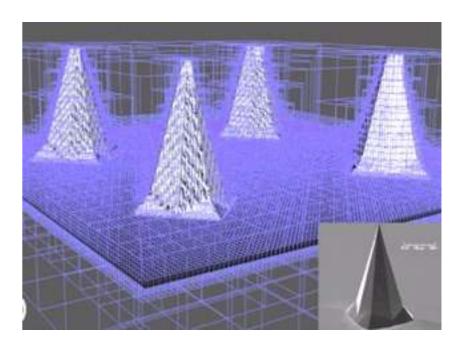
Modeled

## Higher order plane etching



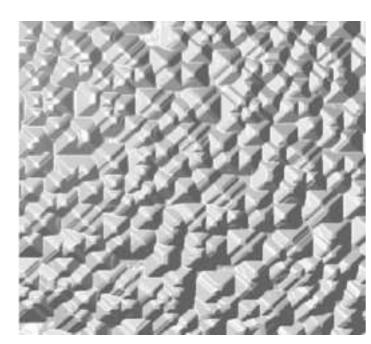
D. Saya, Sensors & Actuators A95 (2002)



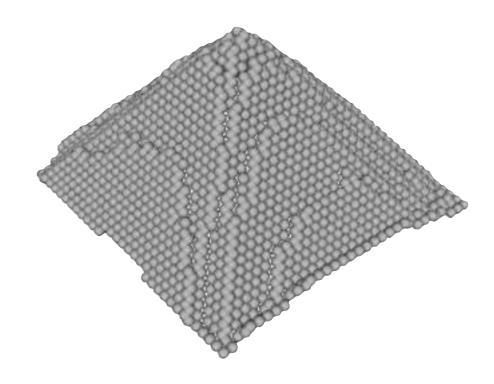


**Simulation results** 

## Surface morphology prediction

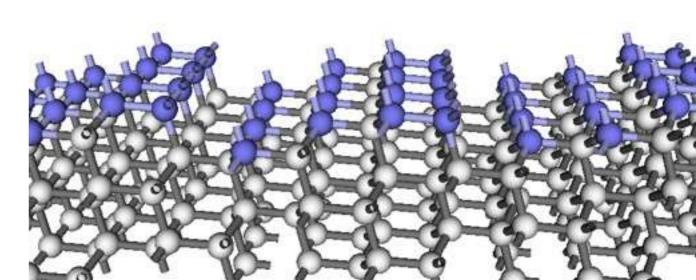


Pyramid like morphology on 100 Si subject to wet anisotropic etching

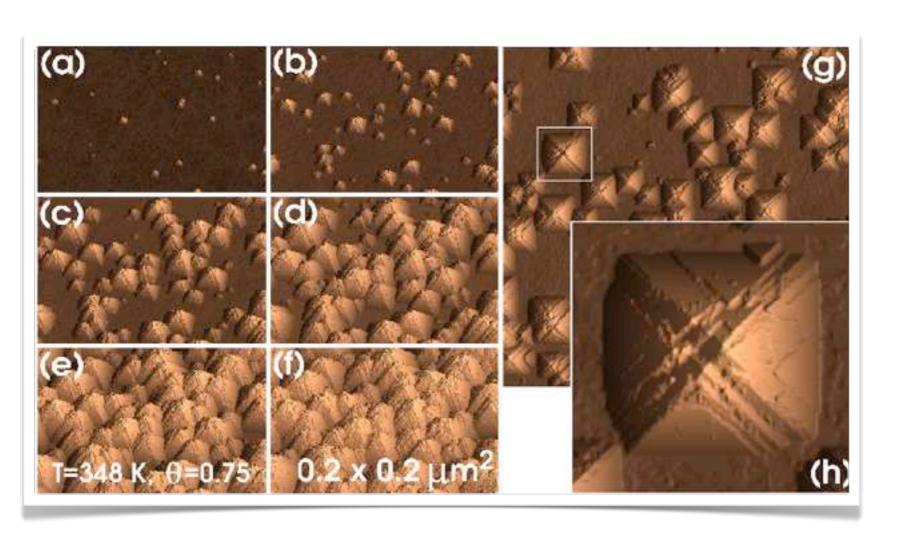


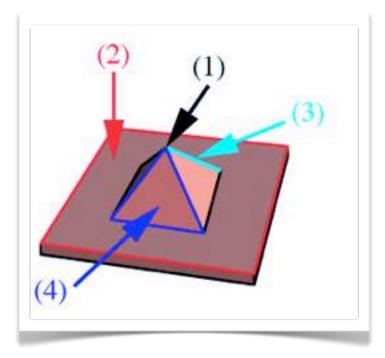
Simulation results predict pyramid formation

Arbitrary Cut Planes <533> to understand the physics



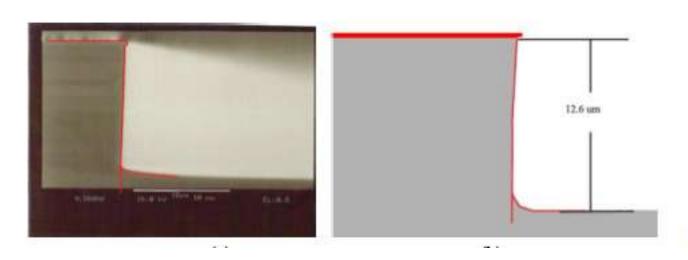
## Surface morphology prediction

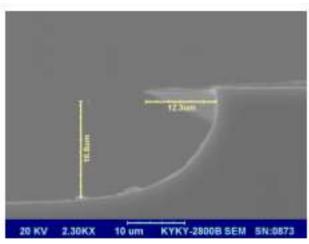


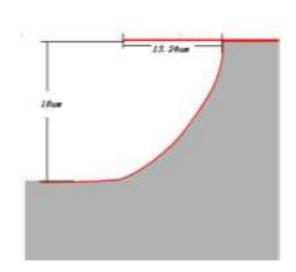


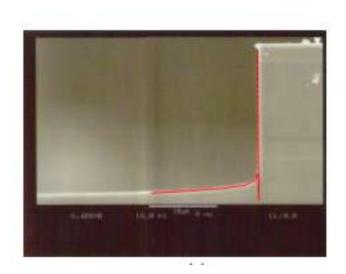
- 1 Micromasking of apex
- 2 Floor moves down fast
- 3 Edges are stable
- 4 Facets are very stable

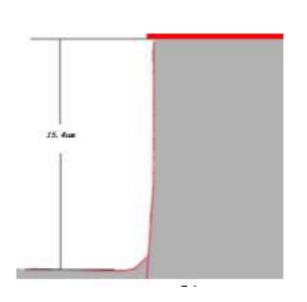
## DRIE Etch characterization experiments (1)

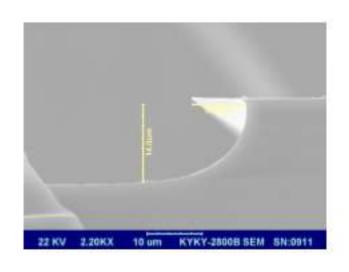


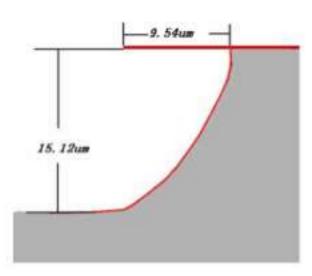




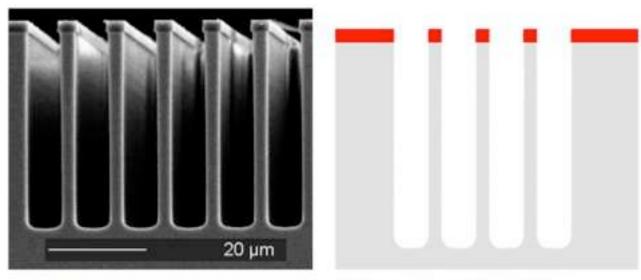




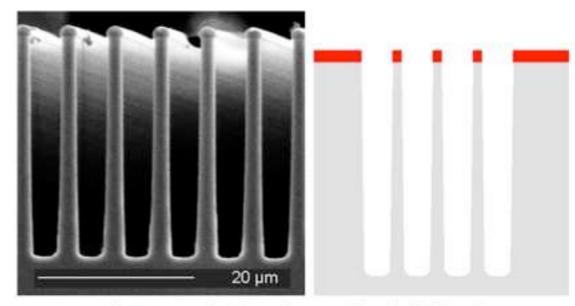




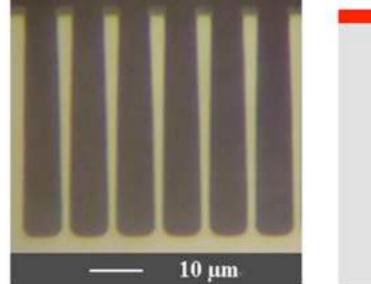
### DRIE Etch characterization experiments (2)

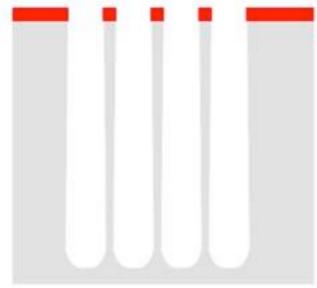


The experimental results of the etching. Comparison of etching 5 µm openings with an etch/dep cycle of 7s/7s.

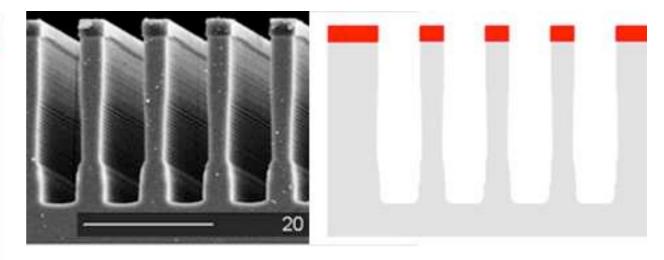


Comparison of etching a 5 µm trench with a 5s/7s cycle



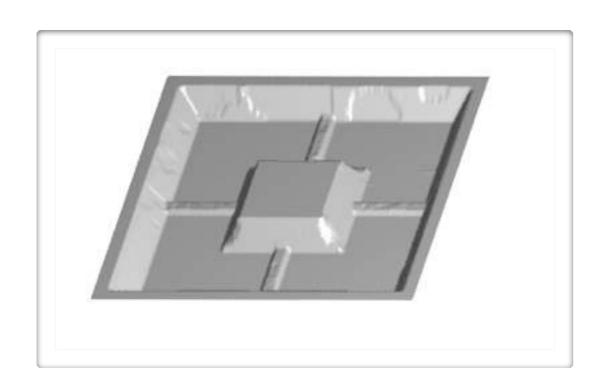


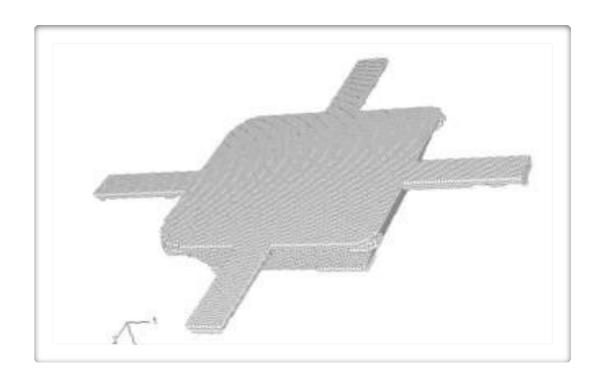
Comparison of etching a 5 µm trench with a 7s/8s cycle

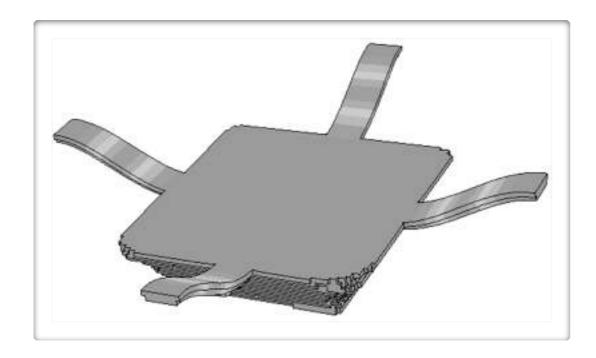


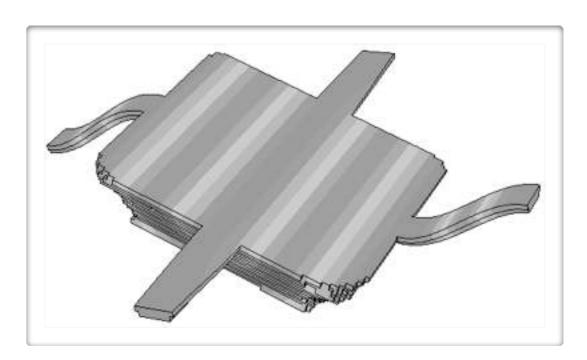
The experimental result of the etching of trenches using three etching steps with different etching/polymerization time configurations. 7s/7s, 9s/7s and 5s/7s are used sequentially, each for 5 minutes.

## **Output to FEA**

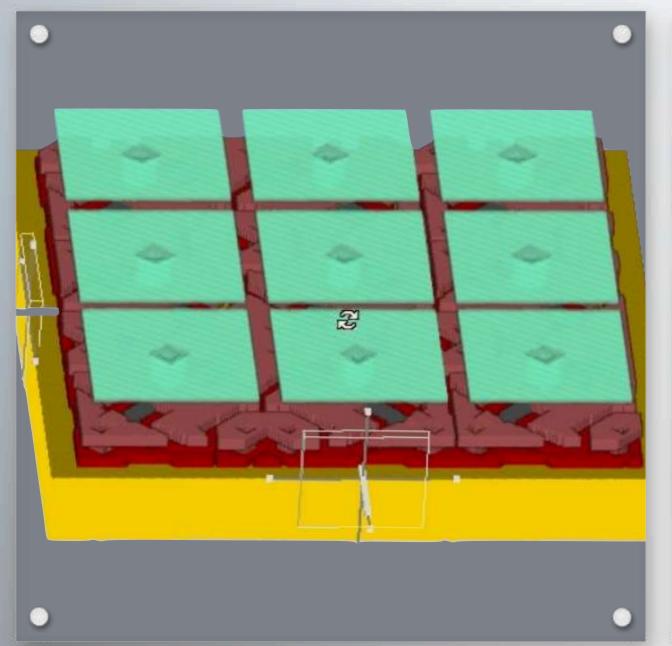


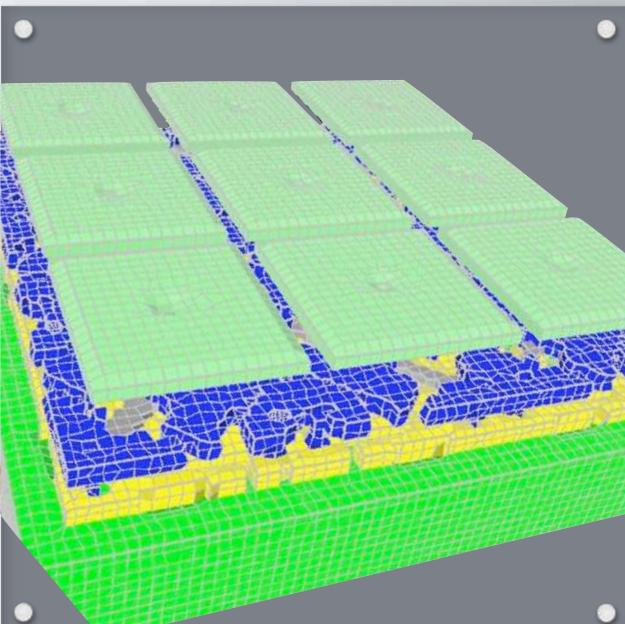






Interface with analysis tools: Direct export to IntelliSuite and other industry formats





### PROCESS TO MODEL

## Fastfield solvers



## Fastfield capabilities (Structural)









#### **Fastfield Multiphysics**

Unique FEM-BEM formulation 64 bit multi-processor enabled 5-10X than pure FEM based

#### **Fully coupled**

Thermal
Electrostatics
Mechanical
Fluidics
Contact physics
Piezo
Magnetostatics

#### **Specialized engines**

BioMEMS High frequency EMag

#### **Extraction**

Multiphysics capture
Efficient for verification
Lagrangian models
1000X more efficient that FEA

## What is Fastfield Multiphysics?

#### Coupled solver formulation

ANSYS, Algor, Comsol, etc are all pure Finite Element tools

#### Best solver for each physics domain

Boundary Element Method (BEM): Electrostatics, Electromagnetics Finite Element Method (FEM): Thermal, Mechanical and Electromagnetics Volume of Flow (VoF) and Finite Volume (FV): Fluidics, Electrokinetics, Chemical Reactions

#### Advanced pre-correction and solver techniques

Pre-corrected FFT (pFFT++), GMRES, Arnoldi, OpenMP based multi-processor solvers

## Why Fastfield Multiphysics?

#### Speed and efficiency

2-10X Faster than pure FEA formulation (Algor, Ansys, Comsol, etc) Handle large real world problems

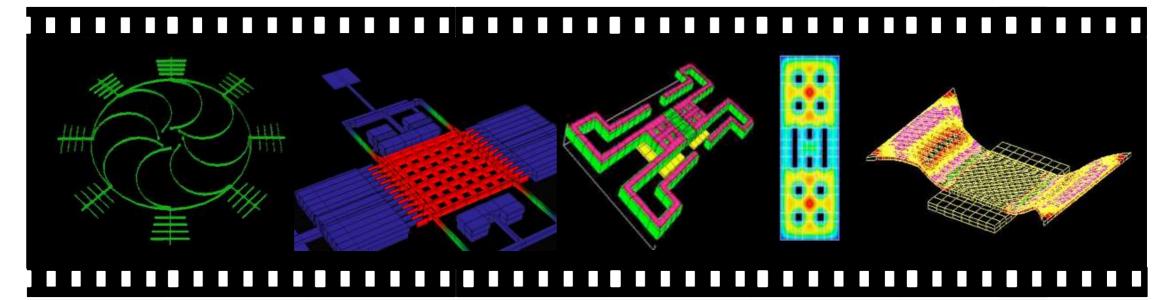
#### Surface meshing vs volume meshes

Internal volumes, air gaps, etc do not need to be meshed Ease of meshing, no costly re-meshing during deformation

#### **Ease of convergence**

Quickly run your analysis without convergence issues

Deal with large deformations, contact and post-contact without convergence issues

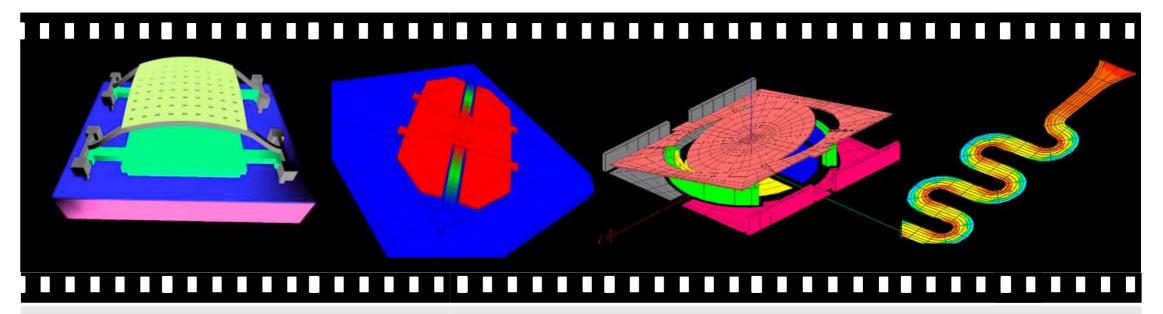


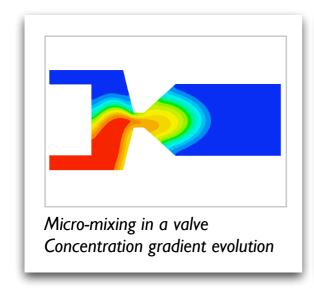
Hitachi RF Tunable Filter

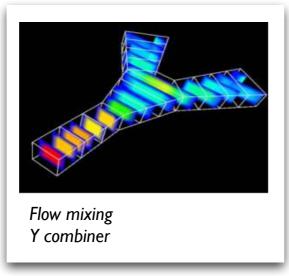
NASA Adaptive optics

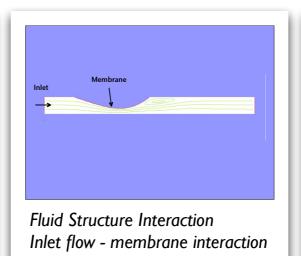
Corning
3D Optical cross connect

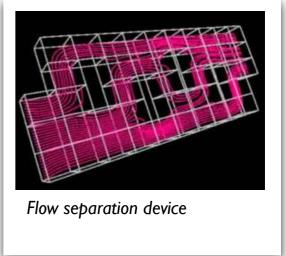
NASA Radiation detectors



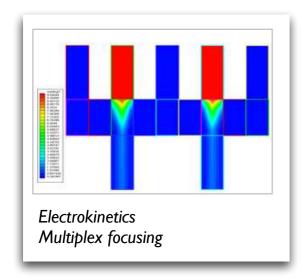


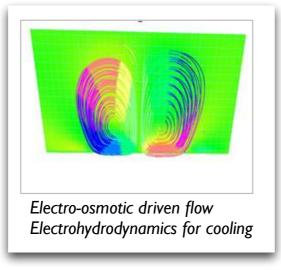


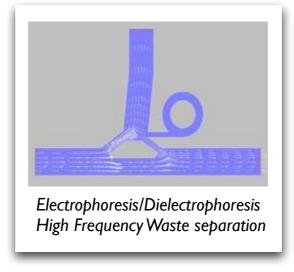


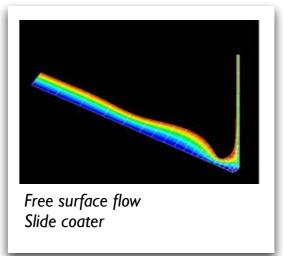


Microfluidics• Electrokinetics • Transport stochiometry • Heat transfer • Electro-Wetting on Dielectric (EWOD) • Digital droplet microfluidics • Free Surface Flow • Fluid Structure Interaction • Electrochemistry • Micro-mixing • Electrophoresis • Dielectrophoresis • Capillary flow and electroseparation • Electro-osmosis • Electro-hydrodynamics • Micro-pumps



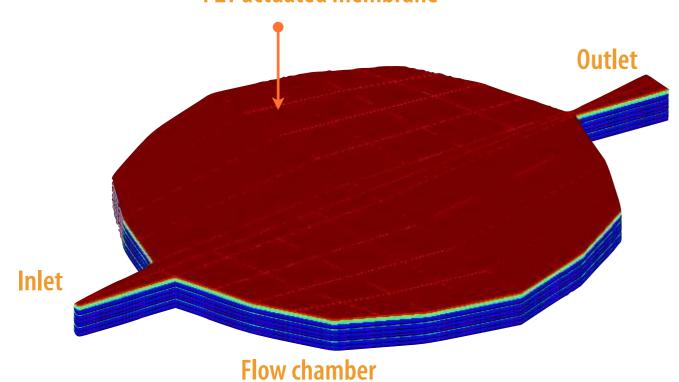




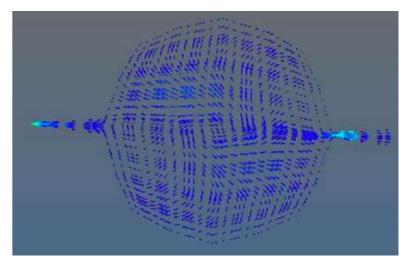


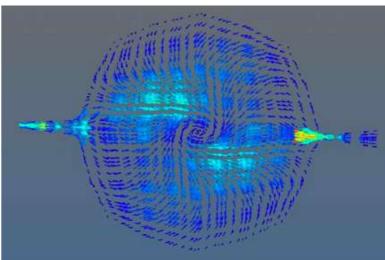
## Advanced FSI

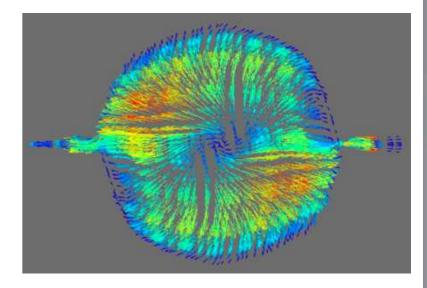
#### **PZT** actuated membrane



**Example**: Valveless piezoelectrically actuated micropump

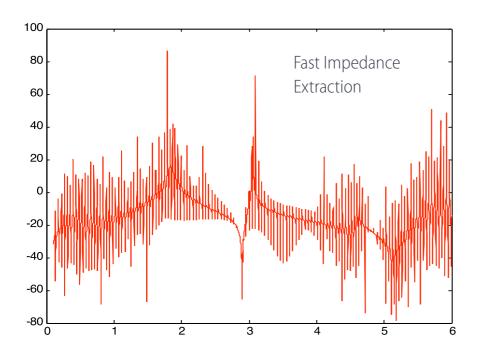


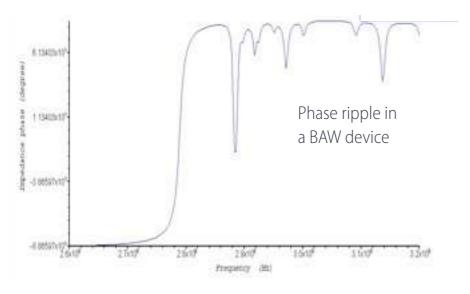


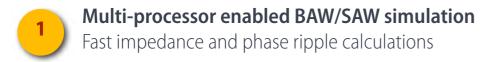


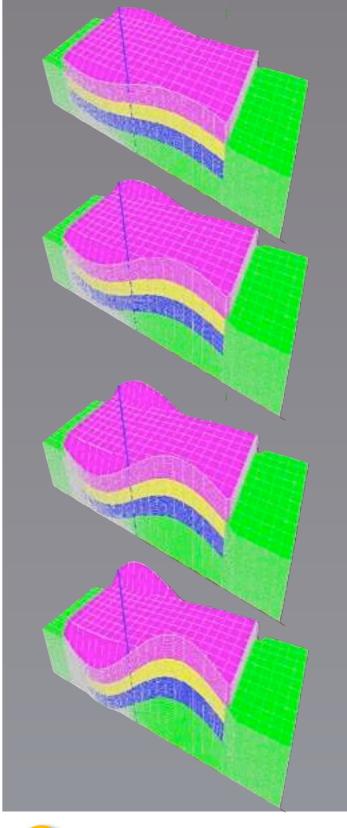
Flow evolution in a piezoelectric membrane micro pump

## Piezo-Acoustics



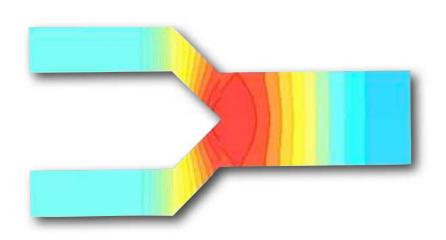




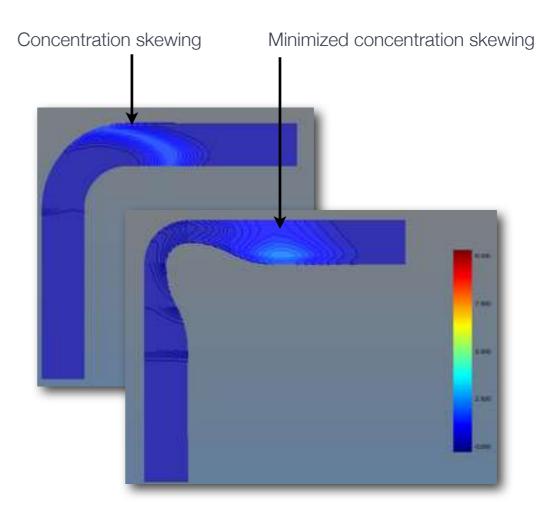


Piezo-acoustic wave generation

# Microfluidics



Two reactants meeting at the junction and reacting to form a new analyte. Support for multivalent reactions is new in v 8.5



Enhanced ion drag calculations allows you to optimize elbow turns to minimize concentration skews



#### **Enhanced Chemical Reaction**

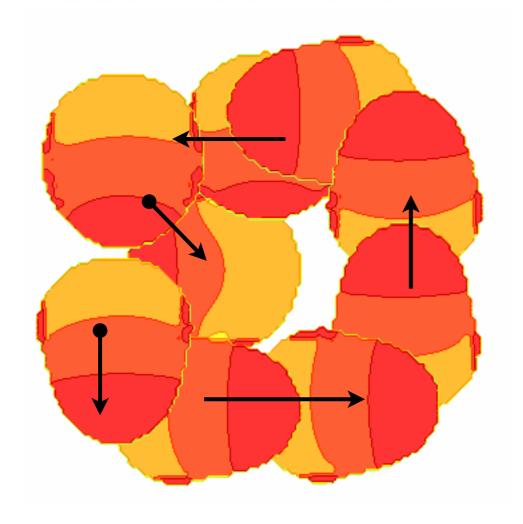
Microfluidics with enhanced transport kinetics



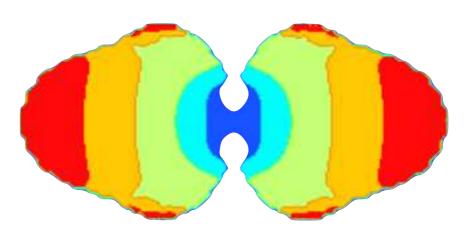
#### **Enhanced transport behavior**

Multivalent lon drag calculations in electrokinetic transport

# Microfluidics







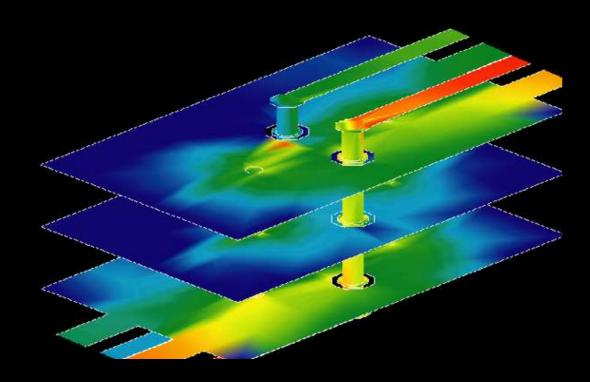
Droplet fission (top view)



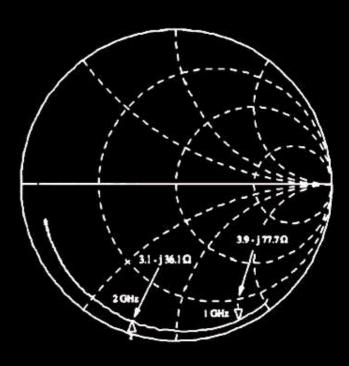
**Electrowetting on dielectric (EWOD)** 

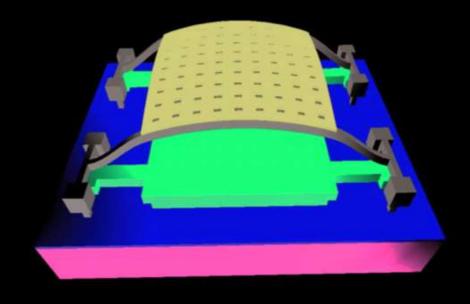
3D Electrowetting calculations

## ElectroMagnetics



IntelliSuite is the only tool on the market that allows you to perform coupled Thermo-Electro-Mechanical & Full Wave ElectroMagnetic analyses— this is particularly useful in designing deformable RF-MEMS such as switches, tunable capacitors and varactors.





## Extraction & verification



### What is extraction?

### Simplifying a full 3D model into behavioral model

Convert FEA/BEA model (large DOFs) into computationally efficient model

Develop pre-computed energy based model that captures multiphysics

#### What is extracted?

Mechanical Strain Energy of Modes of Interest (Including stress and stress gradient effects)

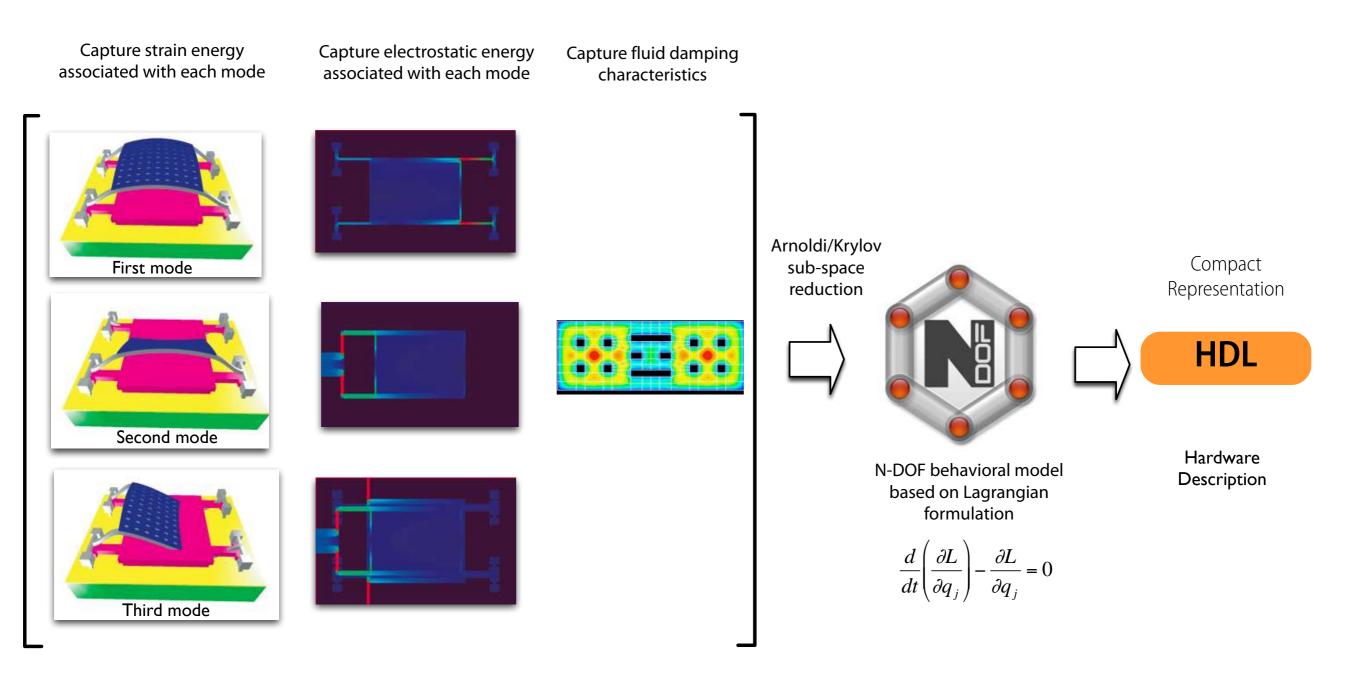
Capacitive energy

Thermal effects (deformation due to temperature change)

Fluidic Structure Interaction (due to compressive or non-compressive media)

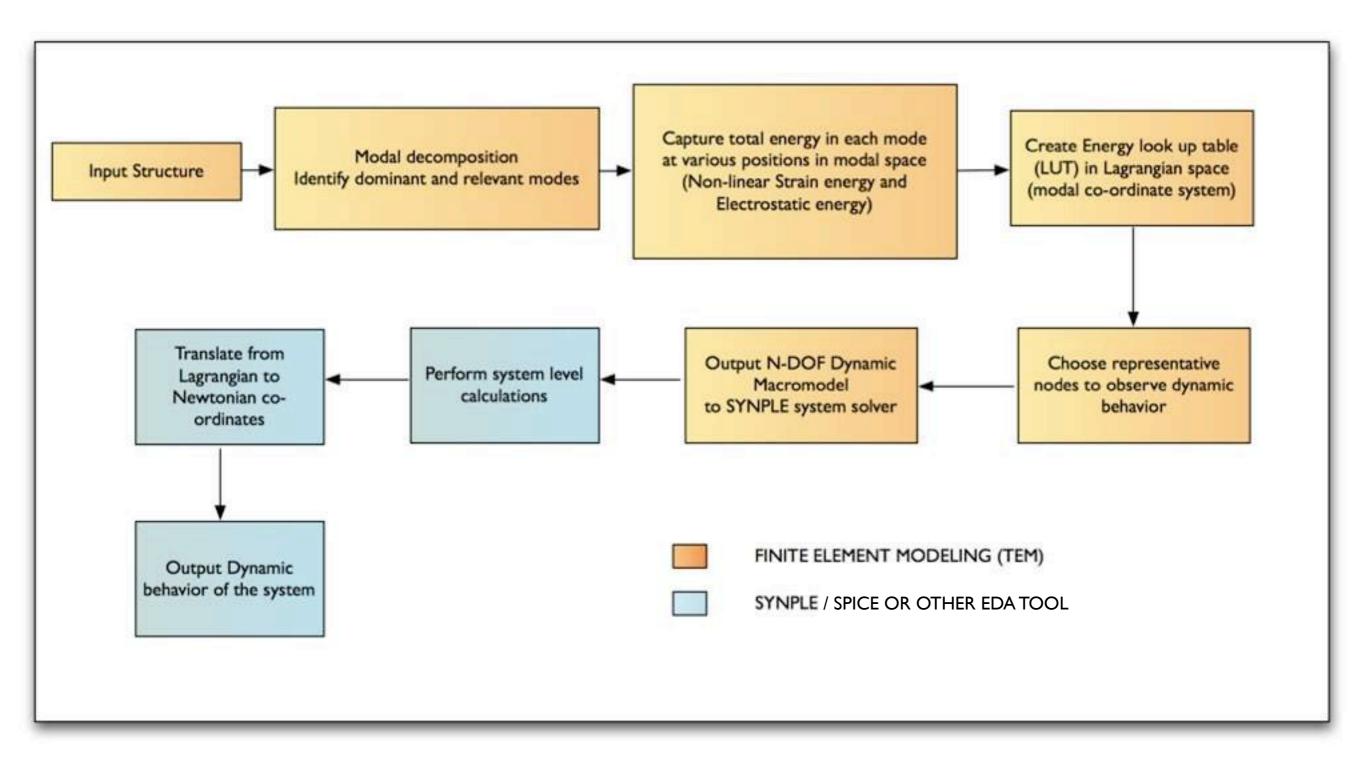
Other dissipation sources (thermoelastic damping (v8.6.1) and anchor acoustic losses (v8.6.2))

## System Model Extraction (SME)



- Capture total energy of relevant mode (Mechanical, Electrostatic, Dissipation)
- Krylov/Arnoldi methods to generate Lagrangian formulation
- **3** Create Compact model for system modeling

### System model extraction (SME) flow chart



Summary: Convert problem from Newtonian (inertia based) to more efficient Lagrangian domain (energy based)

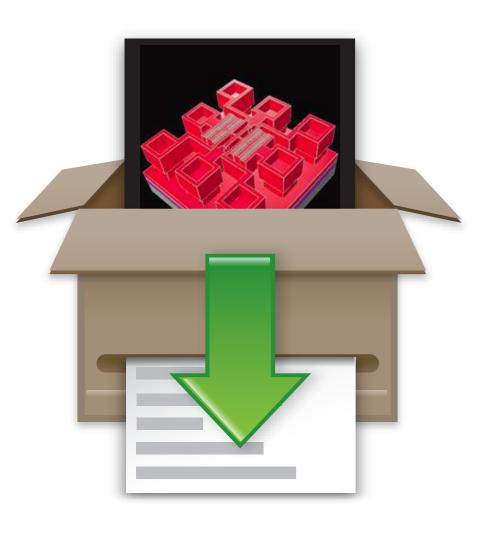
## **SME** advantages

- Automated full multi-physics capture
- 1000 X faster than pure FEA
- Matches FEA to within 1% accuracy
- Fully capture harmonic responses

- 3D MEMS system simulation
- Device and package level extraction
- Automated VHDL/ Verilog/ SPICE generation



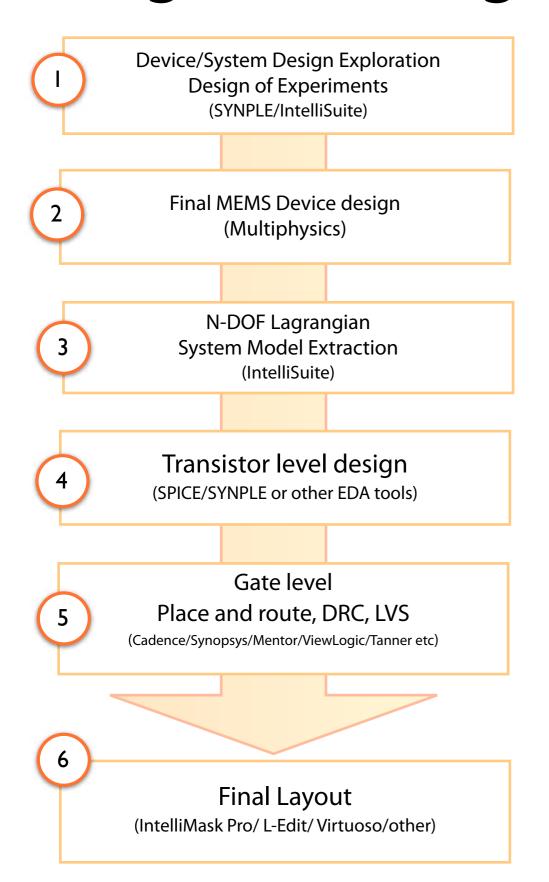
## EDA Linker capabilities (compatibility)



- Create accurate N-DOF dynamic system model from MEMS FEA/BEA model
- Output system model into SPICE, HDL, and Simulink formats

- Compatible with EDA tools from Cadence,
   Mathworks, Mentor, Synopsys and Tanner
- Integrated CMOS-MEMS (SoC/SiP) compatibility

### Integrated design flow for MEMS + IC



MEMS-CMOS integration design flow can be based on:

- VHDL-AMS
- Verilog-A
- √ SPICE netlist
- √ Matlab/Simulink .MEX

### What is verification?

#### Model verification (Schematic vs 3D)

Verify schematic model and 3D model match

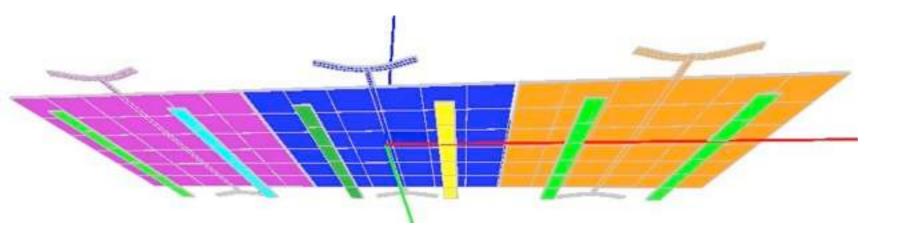
Ensure MEMS model used in circuit development is accurate

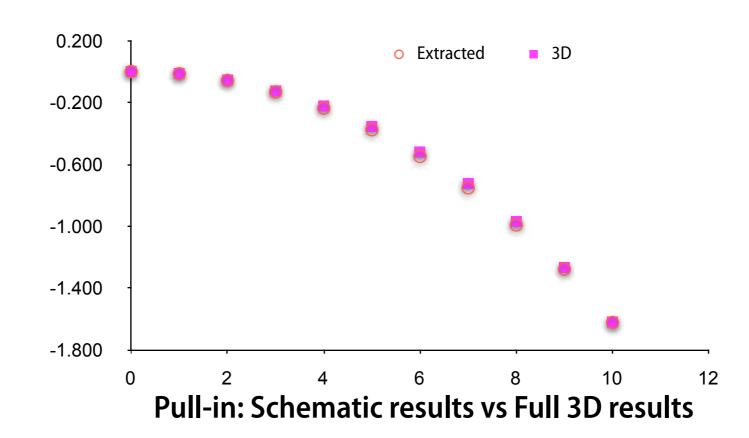
### Physical verification ('Tape Out')

Verify physical layout is consistent with Design Rules

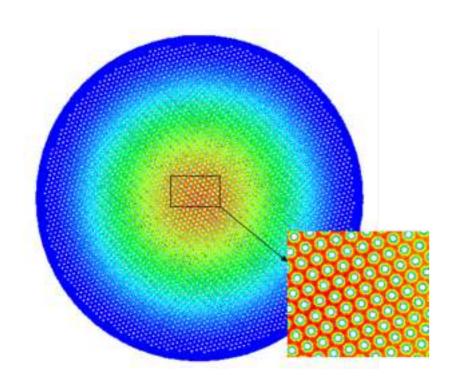
Ensure design meets manufacturability criteria

### Static model verification

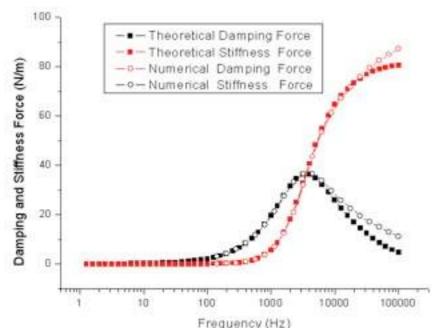




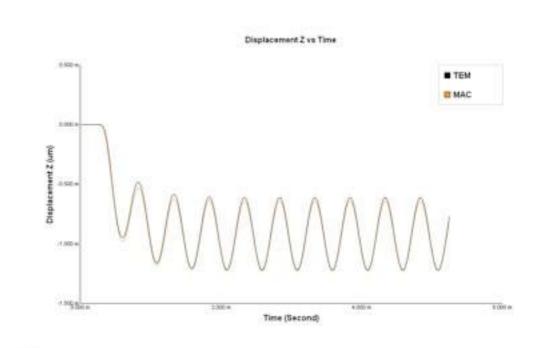
### Damping model verification



Perforated condenser membrane

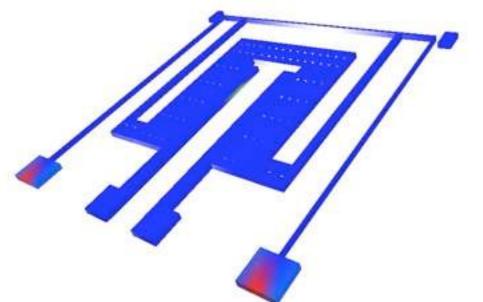


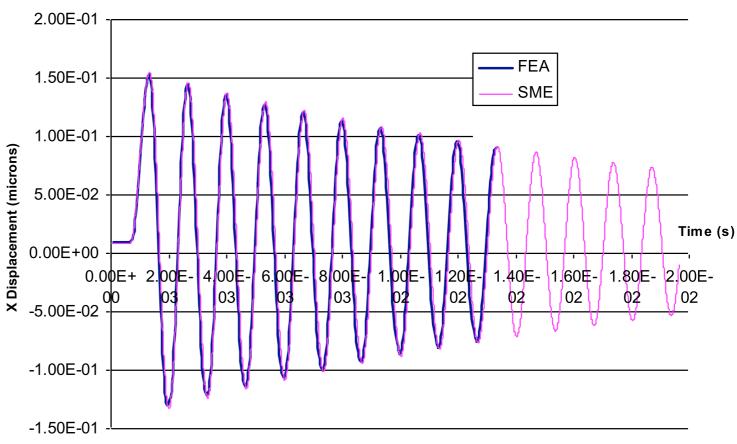
Full capture of fluidic damping and spring force



Full 3D (TEM) vs Macromodel comparison

## Dynamic model verification





Transient response of device: Schematic vs FEA (3D)

### Summary

- End to end design tools for MEMS
- Simulate MEMS at any level: Ab-initio, Component, Device, Algorithm and System
- Flexible design flow to achieve accurate and fast results
- Used by major customers in 30+ countries



Thank you

ありがとう・謝謝・धन्यवाद・شكرا لكم

Grazie •Merci • Gracias • Danke •Obrigado • Dank U •Terima Kasih

Dziękuję • Cπαcибо • Ευχαριστώ • Asante Sana • Dankie

